# **TJA1445** High-speed CAN transceiver with partial networking Rev. 1.0 — 16 October 2024

Product data sheet



# 1 General description

The TJA1445 is a high-speed CAN transceiver that provides an interface between a controller area network (CAN) or flexible data rate CAN (CAN FD) protocol controller and the physical two-wire CAN bus. TJA1445 transceivers implement the CAN physical layer as defined in ISO 11898-2:2024 and SAE J2284-1 to SAE J2284-5, making them fully interoperable with high-speed classical CAN and CAN FD transceivers. The TJA1445 was developed in compliance with ISO 26262, achieving ASIL B.

The TJA1445 features very low power consumption in Standby and Sleep modes. It supports CAN partial networking by means of selective wake-up functionality as specified in ISO 11898-2:2024, making the TJA1445 the ideal choice for CAN system implementations where only nodes that are needed are to be activated. Nodes that are not needed for the function being performed can be powered down to minimize system power consumption, even when CAN bus traffic is running.

The TJA1445 includes an SPI for configuration, mode control and diagnostics. The TJA1445B additionally features three general-purpose I/O pins (GPIO) and a CAN transmitter enable/disable input.

The TJA1445 can be configured to ignore CAN FD frames while waiting for a valid wake-up frame. This additional feature of partial networking, called CAN FD passive, is the perfect fit for networks that support a mix of classical CAN and CAN FD communication.

## 2 Features and benefits

## 2.1 General

- ISO 11898-2:2024 parameter sets A-B, SAE J2284-1 to SAE J2284-5 and SAE J1939-14 compliant
- ISO 26262, ASIL B compliant
- · Partial networking capability through selective wake-up functionality
- Configurable general-purpose I/O (GPIO) pins (TJA1445B)
- Second RXD and/or TXD pins (RXD2/TXD2), configurable via GPIO (TJA1445B)
- Direct transmitter on/off control input (TXEN\_N) (TJA1445B)
- Autonomous bus biasing
- · Low electromagnetic emission (EME) and high electromagnetic immunity (EMI)
- Qualified according to AEC-Q100 Grade 1
- VIO input for interfacing with 1.8 V, 3.3 V to 5 V microcontrollers
- ListenOnly mode for node diagnosis and failure containment
- TJA1445A available in an SO14 package and leadless HVSON14 package with automatic optical inspection (AOI) capabilities
- TJA1445B available in a DHVQFN18 package with automatic optical inspection (AOI) capabilities
- Dark green product (halogen free and restriction of hazardous substances (RoHS) compliant)



- · Selectable interrupts on RXD; option to signal only wake-up and power-on related interrupts or all interrupts
- 4-byte general-purpose memory
- · SPI system reset
- End-of-line microcontroller flashing support through CAN pins
- Selectable WAKE pin filter time

## 2.2 Predictable and fail-safe behavior

- Undervoltage detection on all supply pins with defined behavior below the undervoltage thresholds
- Functionality guaranteed from the undervoltage detection thresholds up to the maximum limiting voltage values
- Transceiver disengages from the bus (high-ohmic) when the battery voltage drops below the Off mode threshold
- Internal biasing of TXD to enable defined fail-safe behavior

## 2.3 Low-power management

- Very low-current Standby and Sleep modes, with local and remote wake-up capability
- Local wake-up via the WAKE pin
- Remote wake-up via a wake-up pattern (WUP) or wake-up frame (WUF)
- Configurable CAN wake-up pattern (dom-rec-dom or dom-rec-dom-rec) according to ISO 11898-2:2024.
- Selective wake-up according to ISO 11898-2:2024
- Entire node containing the TJA1445 can be powered down via INH while still supporting local and remote wake-up
- Only  $V_{\text{BAT}}$  is needed to support local and remote wake-up
- · Support for pretended networking through low-power ListenOnly mode

## 2.4 Diagnosis and Protection

- Overtemperature diagnosis and protection
- Transmit data (TXD) dominant time-out diagnosis and protection
- Bus dominant failure diagnosis
- Cold start diagnosis (first battery connection)
- High ESD handling capability on the bus pins
- Bus pins and VBAT protected against automotive transients

# 3 Quick reference data

| Symbol                 | Parameter                                  | Conditions   | Min  | Тур | Max  | Unit |
|------------------------|--|--|------|-----|------|------|
| V <sub>BAT</sub>       | battery supply voltage                     |  | 4.75 | -   | 40   | V    |
| I <sub>BAT</sub>       | battery supply current                     | Normal mode or (ListenOnly mode;<br>VBATVCC = 1 or LPL = 0); $V_{BAT} \le 28 \text{ V}$                              | -    | -   | 400  | μA   |
|                        |  | ListenOnly mode; VBATVCC = 0 and LPL = 1; $V_{BAT} \le 28 \text{ V}$   | -    | -   | 525  | μA   |
|                        |  | Sleep or Standby mode; CAN Offline Bias<br>mode; partial networking enabled; T <sub>vj</sub> < 85 °C;<br>VBATVCC = 0 | -    | -   | 450  | μA   |
|                        |  | Sleep or Standby mode; CAN Offline mode; $T_{vj}$ < 85 °C  | -    | 12  | 20   | μA   |
| V <sub>uvd(VBAT)</sub> | undervoltage detection voltage on pin VBAT |  | 4.25 | -   | 4.75 | V    |
| V <sub>CC</sub>        | supply voltage                             |  | 4.5  | -   | 5.5  | V    |
| I <sub>CC</sub>        | supply current                             | Normal mode; transmitter dominant  | -    | 38  | 60   | mA   |
|                        |  | Normal or (ListenOnly mode and LPL = 0);<br>transmitter recessive  | -    | 6   | 9    | mA   |
|                        |  | ListenOnly mode; LPL = 1; VBATVCC = 1;<br>$T_{vj} < 150 \text{ °C}$  | -    | 90  | 165  | μA   |
|                        |  | ListenOnly mode; LPL = 1; VBATVCC = 0;<br>$T_{vj} < 150 \text{ °C}$  | -    | -   | 30   | μA   |
|                        |  | Sleep or Standby mode; T <sub>vj</sub> < 85 °C   | -    | -   | 3    | μA   |
| V <sub>uvd(VCC)</sub>  | undervoltage detection voltage on pin VCC  |  | 4    | -   | 4.5  | V    |
| V <sub>IO</sub>        | supply voltage                             |  | 1.71 | -   | 5.5  | V    |
| I <sub>IO</sub>        | supply current                             | Normal or ListenOnly mode (excluding pull-up currents on $V_{IO}$ -related pins)                                     | -    | -   | 5    | μA   |
|                        |  | Standby or Sleep mode; T <sub>vj</sub> < 85 °C   | -    | -   | 2    | μA   |
| V <sub>uvd(VIO)</sub>  | undervoltage detection voltage on pin VIO  |  | 1.5  | -   | 1.71 | V    |
| V <sub>ESD</sub>       | electrostatic discharge voltage            | IEC 61000-4-2 on pins CANH, CANL   | -8   | -   | +8   | kV   |
| V <sub>CANH</sub>      | voltage on pin CANH                        | limiting value   | -36  | -   | +40  | V    |
| V <sub>CANL</sub>      | voltage on pin CANL                        | limiting value   | -36  | -   | +40  | V    |
| T <sub>vj</sub>        | virtual junction temperature               |  | -40  | -   | +150 | °C   |

## 4 Ordering information

| Type number | Package  | Package  |           |  |  |  |  |  |  |
|-------------|----------|--|-----------|--|--|--|--|--|--|
|             | Name     | Description  | Version   |  |  |  |  |  |  |
| TJA1445AT   | SO14     | plastic small outline package; 14 leads; body width 3.9 mm   | SOT108-1  |  |  |  |  |  |  |
| TJA1445ATK  | HVSON14  | plastic thermal enhanced very thin small outline package; no leads; 14 terminals; body 3 × 4.5 × 0.85 mm | SOT1086-2 |  |  |  |  |  |  |
| TJA1445BHG  | DHVQFN18 | plastic thermal enhanced very thin small outline package; no leads; 18 terminals; body 3 × 4.5 × 0.85 mm | SOT2163-1 |  |  |  |  |  |  |

#### Table 3. Feature overview of the TJA1445 family

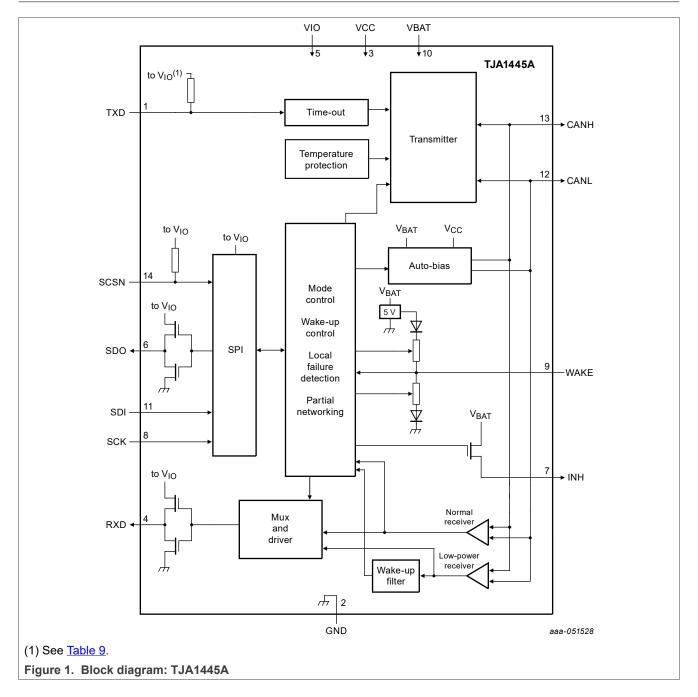
See Section 18 for a feature overview of the complete TJA1445x/TJA1446x/TJA1465x/TJA1466x family.

|          | Partia            | Partial Networking |                |                       | V <sub>IO</sub> supply |                       | Data rate S           |                        | Special features            |           |            |           |              |   |  |              |
|----------|-------------------|--------------------|----------------|-----------------------|------------------------|-----------------------|-----------------------|------------------------|-----------------------------|-----------|------------|-----------|--------------|---|--|--------------|
| Device   | Selective wake-up | CAN FD passive     | CAN XL passive | 1.8 V V <sub>IO</sub> | 3.3 V V <sub>IO</sub>  | 5.0 V V <sub>IO</sub> | Up to 5 Mbit/s CAN FD | Up to 8 Mbit/s CAN SIC | ISO 26262 ASIL B compliance | GPIO pins | TXEN_N pin | RST_N pin | FSO/LIMP pin | V <sub>io</sub> undervoltage monitoring | V <sub>io</sub> overvoltage monitoring | Q&A watchdog |
| TJA1445A | •                 | •                  |                | •                     | •                      | •                     | •                     |                        | •                           |           |            |           |              | •                                       |  |              |
| TJA1445B | •                 | •                  |                | •                     | •                      | •                     | •                     |                        | •                           | 3         | •          |           |              | •                                       |  |              |

# TJA1445

High-speed CAN transceiver with partial networking

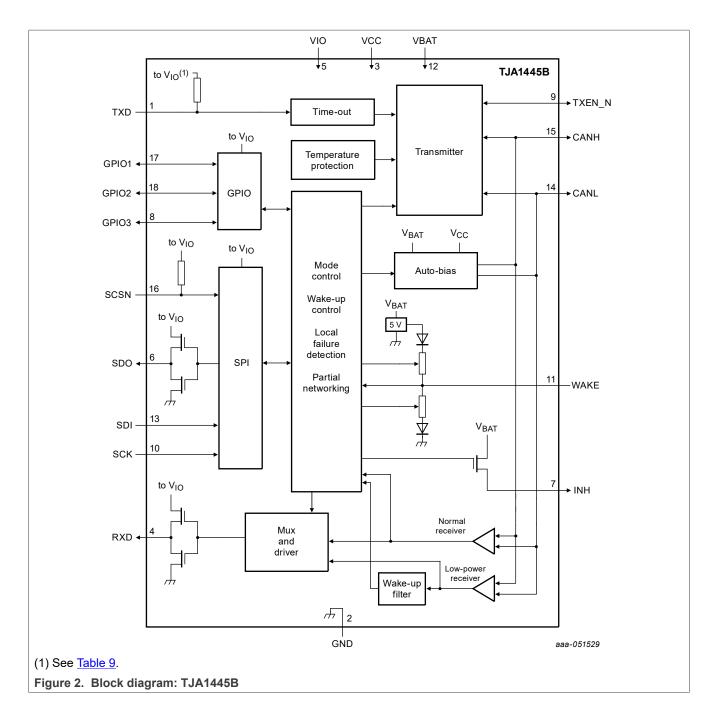
# 5 Block diagram



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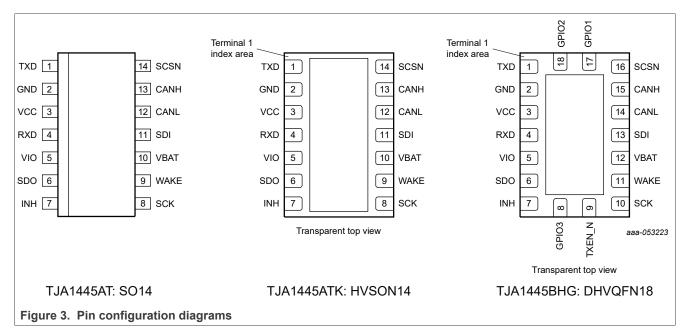
# TJA1445

## High-speed CAN transceiver with partial networking



## 6 Pinning information

## 6.1 Pinning



## 6.2 Pin description

| Table 4. | Pin | description: | TJA1445A |
|----------|-----|--------------|----------|
|----------|-----|--------------|----------|

| Symbol             | Pin | Type <sup>[1]</sup> | Description  |
|--------------------|-----|---------------------|--|
| TXD                | 1   | I                   | transmit data input  |
| GND <sup>[2]</sup> | 2   | G                   | ground   |
| VCC                | 3   | Р                   | supply voltage for CAN transmitter   |
| RXD                | 4   | 0                   | receive data output  |
| VIO                | 5   | Р                   | supply voltage for I/O level adapter   |
| SDO                | 6   | 0                   | SPI data output  |
| INH                | 7   | AO                  | inhibit output for switching external voltage supplies or indicating wake-up from Sleep mode (active-HIGH) |
| SCK                | 8   | I                   | SPI clock input  |
| WAKE               | 9   | AI                  | local wake-up input  |
| VBAT               | 10  | Р                   | battery supply voltage   |
| SDI                | 11  | I                   | SPI data input   |
| CANL               | 12  | AIO                 | LOW-level CAN bus line   |
| CANH               | 13  | AIO                 | HIGH-level CAN bus line  |
| SCSN               | 14  | I                   | SPI chip select input (active-LOW)   |

[1] I: digital input; O: digital output; AI: analog input; AO: analog output; AIO: analog input/output; P: power supply; G: ground.

[2] HVSON14 package die supply ground is connected to both the GND pin and the exposed center pad. The GND pin must be soldered to board ground. For enhanced thermal and electrical performance, it is also recommended to solder the exposed center pad to board ground.

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| Table 5. Pin description: IJA1445B |     |                     |  |  |  |  |  |  |
|------------------------------------|-----|---------------------|--|--|--|--|--|--|
| Symbol                             | Pin | Type <sup>[1]</sup> | Description  |  |  |  |  |  |
| TXD                                | 1   | I                   | transmit data input  |  |  |  |  |  |
| GND <sup>[2]</sup>                 | 2   | G                   | ground   |  |  |  |  |  |
| VCC                                | 3   | Р                   | supply voltage for CAN transmitter   |  |  |  |  |  |
| RXD                                | 4   | 0                   | receive data output  |  |  |  |  |  |
| VIO                                | 5   | Р                   | supply voltage for I/O level adapter   |  |  |  |  |  |
| SDO                                | 6   | 0                   | SPI data output  |  |  |  |  |  |
| INH                                | 7   | AO                  | inhibit output for switching external voltage supplies or indicating wake-up from Sleep mode (active-HIGH) |  |  |  |  |  |
| GPIO3                              | 8   | I/O                 | general purpose input/output 3   |  |  |  |  |  |
| TXEN_N                             | 9   | I/O                 | CAN transmitter enable/disable input (active-LOW)  |  |  |  |  |  |
| SCK                                | 10  | I                   | SPI clock input  |  |  |  |  |  |
| WAKE                               | 11  | AI                  | local wake-up input  |  |  |  |  |  |
| VBAT                               | 12  | Р                   | battery supply voltage   |  |  |  |  |  |
| SDI                                | 13  | I                   | SPI data input   |  |  |  |  |  |
| CANL                               | 14  | AIO                 | LOW-level CAN bus line   |  |  |  |  |  |
| CANH                               | 15  | AIO                 | HIGH-level CAN bus line  |  |  |  |  |  |
| SCSN                               | 16  | I                   | SPI chip select input (active-LOW)   |  |  |  |  |  |
| GPIO1                              | 17  | I/O                 | general purpose input/output 1   |  |  |  |  |  |
| GPIO2                              | 18  | I/O                 | general purpose input/output 2   |  |  |  |  |  |

#### Table 5. Pin description: TJA1445B

[1] [2]

I: digital input; O: digital output; AI: analog input; AO: analog output; AIO: analog input/output; P: power supply; G: ground. DHVQFN18 package die supply ground is connected to both the GND pin and the exposed center pad. The GND pin must be soldered to board ground. For enhanced thermal and electrical performance, it is also recommended to solder the exposed center pad to board ground.

## 7 Functional description

## 7.1 Supply

## Table 6. Supply description

| Supply pin | Supply           | Description  |
|------------|------------------|--|
| VBAT       | V <sub>BAT</sub> | Main supply for the device, needed for all internal processes; supplies the CAN receivers                          |
| VCC        | V <sub>CC</sub>  | Supply for the CAN transmitter and for bus biasing   |
| VIO        | V <sub>IO</sub>  | Supply and reference level for the digital interface pins TXD and RXD, the SPI interface, TXEN_N and the GPIO pins |

## 7.2 System operating modes

<u>Table 7</u> contains a summary of the system finite state machine (FSM\_MAIN) operating modes. A mode transition diagram is shown in <u>Figure 4</u>. Mode changes are completed after transition time  $t_{t(moch)}$ . Abbreviations used in the mode transition diagram are defined in <u>Table 8</u>.

| Table 7. | FSM | MAIN | operating | modes |
|----------|-----|------|-----------|-------|
|----------|-----|------|-----------|-------|

| Operating mode | Description  |
|----------------|--|
| Off            | Device is deactivated  |
| Boot           | Device loads the configuration and registers are reset to default values |
| Check_SNM      | Device checks the CAN bus status   |
| Standby        | Device is in the first-level low-power mode with INH active              |
| Sleep          | Device is in the second-level low-power mode with INH inactive           |
| ListenOnly     | Device is able to receive CAN data from the bus                          |
| Normal         | Device is able to transmit and receive CAN bus traffic                   |

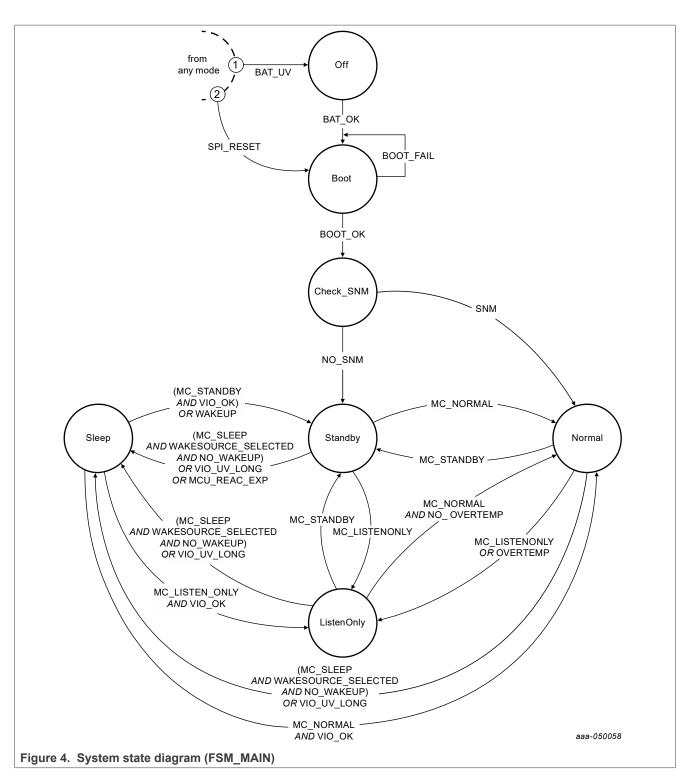
| Category                       | Abbreviation                                 | Definition  |  |  |
|--------------------------------|--|---|--|--|
| VBAT pin status                | BAT_UV                                       | $V_{BAT} < V_{uvd(VBAT)}$ for t > $t_{det(uv)VBAT}$   |  |  |
|                                | BAT_OK                                       | $V_{BAT} > V_{uvd(VBAT)}$ for t > $t_{rec(uv)VBAT}$   |  |  |
| Memory check during boot phase | BOOT_OK                                      | passed internal memory consistency check (takes up to t <sub>startup</sub> )                        |  |  |
|                                | BOOT_FAIL                                    | failed internal memory consistency check  |  |  |
| Start-to-Normal mode check     | SNM  | CAN bus must remain dominant for t > $t_{t(snm)}$ in Check_SNM mode                                 |  |  |
|                                | NO_SNM                                       | CAN bus detected recessive in CHECK_SNM<br>mode or valid SPI message detected since Boot<br>mode    |  |  |
| Wake-up request status         | WAKEUP                                       | valid local or remote wake-up trigger received  |  |  |
|                                | NO_WAKEUP                                    | no valid local or remote wake-up trigger received   |  |  |
| Wake-up source selection       | WAKESOURCE_SELECTED                          | local (WAKE) and/or remote wake-up source selected  |  |  |
| Temperature status             | NO_OVERTEMP                                  | T <sub>j</sub> < T <sub>j(sd)rel</sub>  |  |  |
|                                | OVERTEMP                                     | $T_j > T_{j(sd)}$   |  |  |
| VIO pin status                 | VIO_UV_LONG                                  | $V_{IO} < V_{uvd(VIO)}$ for t > t <sub>det(uv)long</sub>  |  |  |
|                                | VIO_OK                                       | $V_{IO} > V_{uvd(VIO)}$ for t > $t_{rec(uv)}$   |  |  |
| MCU reaction timeout           | MCU_REAC_EXP                                 | no valid SPI activity for t > t <sub>to(MCU)</sub> with a power-<br>on or wake-up interrupt pending |  |  |
| Mode select                    | MC_NORMAL                                    | Normal mode (MC = 1111)   |  |  |
|                                | MC_STANDBY                                   | Standby mode (MC = 0110)  |  |  |
|                                | SPI_WRITE_SLEEP (see <u>Section 7.10.1</u> ) | Sleep mode command (SPI write MC = 0001)  |  |  |
|                                | MC_LISTENONLY                                | ListenOnly mode (MC = 1000)   |  |  |
| SPI system reset               | SPI_RESET                                    | SPI forces system reset (see Section 7.10.2)  |  |  |
|                                | 1  | 1   |  |  |

#### Table 8. State diagram legend

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Transitions that take priority over all others are indicated with priority 1-2 (encircled number at state exit). All other transitions are mutually exclusive.

The device can enter Normal mode directly (SNM) via a boot sequence after power on or a system reset. To pass the SNM check, the CAN bus must be in dominant state before the main state machine enters

Check\_SNM mode and must remain dominant for at least t > t<sub>t(snm)</sub>. When Normal mode was entered directly after booting, bit SNMS in the system status register is set to 1.

## 7.2.1 Pin and functional block states per operating mode

Table 9. Pin state per System operating mode

| All supplies | within c | neratina | range v | with no | error | condition  | nresent  |
|--------------|----------|----------|---------|---------|-------|------------|----------|
| All Supplies | within C | peraing  | runge v |         | 01101 | contantion | present. |

| Pin           | Off/Boot/Check_SNM         | Sleep   | Standby   | ListenOnly                 | Normal                     |
|---------------|----------------------------|---|---|----------------------------|----------------------------|
| TXD           | high-Z                     | pulled HIGH <sup>[1]</sup>                              | pulled HIGH <sup>[1]</sup>                              | pulled HIGH <sup>[1]</sup> | pulled HIGH <sup>[1]</sup> |
| RXD           | high-Z                     | HIGH or LOW<br>when interrupt<br>pending <sup>[2]</sup> | HIGH or LOW<br>when interrupt<br>pending <sup>[2]</sup> | CAN bus status             | CAN bus status             |
| SDO           | high-Z                     | high-Z when<br>SCSN HIGH                                | high-Z when<br>SCSN HIGH                                | high-Z when<br>SCSN HIGH   | high-Z when<br>SCSN HIGH   |
| INH           | high-Z                     | high-Z  | HIGH <sup>[3]</sup>                                     | HIGH <sup>[3]</sup>        | HIGH <sup>[3]</sup>        |
| SCK           | high-Z                     | repeater  | repeater  | repeater                   | repeater                   |
| SDI           | high-Z                     | repeater  | repeater  | repeater                   | repeater                   |
| SCSN          | pulled HIGH <sup>[1]</sup> | pulled HIGH <sup>[1]</sup>                              | pulled HIGH <sup>[1]</sup>                              | pulled HIGH <sup>[1]</sup> | pulled HIGH <sup>[1]</sup> |
| TJA1445B only |                            |   |   |                            |                            |
| GPIO1         | high-Z                     | GPIO  | GPIO  | GPIO                       | GPIO                       |
| GPIO2         | high-Z                     | GPIO  | GPIO  | GPIO                       | GPIO                       |
| GPIO3         | high-Z                     | GPIO  | GPIO  | GPIO                       | GPIO                       |
| TXEN_N        | LOW                        | pulled HIGH <sup>[1]</sup>                              | pulled HIGH <sup>[1]</sup>                              | pulled HIGH <sup>[1]</sup> | pulled HIGH<br>[1]         |

HIGH = driven to  $V_{IO}$  level, as defined in <u>Table 49</u>. [1]

[2] [3] Interrupt pending: at least one bit set in one or more interrupt status registers (see Section 7.10.10).

HIGH = driven to  $V_{BAT}$  level, as defined in <u>Table 49</u>.

| Table 10. Functional state per System operating mode                 |
|--|
| All supplies within operating range with no error condition present. |

| Function      | SPI configuration | Off/Boot/Check_<br>SNM | Sleep                           | Standby                         | ListenOnly   | Normal                                      |
|---------------|-------------------|------------------------|---------------------------------|---------------------------------|--|---|
| SPI           |                   | off                    | on                              | on                              | on   | on  |
| CAN           |                   | high-Z                 | GND or 2.5 V<br>bias (autobias) | GND or 2.5 V<br>bias (autobias) | V <sub>CC</sub> /2 <sup>[1]</sup> bias<br>and receiver<br>active | V <sub>CC</sub> /2 bias and receiver active |
| Local wake-up |                   | off                    | on                              | on                              | on   | on  |
| CAN wake-up   | PNCOK = 0         | off                    | on                              | on                              | off  | off   |
|               | PNCOK = 1         | off                    | off                             | off                             | off  | off   |
| Partial       | PNCOK = 0         | off                    | off                             | off                             | off  | off   |
| networking    | PNCOK = 1         | off                    | on                              | on                              | on   | on  |
| Overtemp      |                   | off                    | off                             | off                             | off <sup>[2]</sup>   | on  |

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[1] 2.5 V when LPL = 1.

[2] Overtemperature detection remains active after a transition from Normal mode to ListenOnly mode due to an overtemperature condition.

## 7.2.2 Local wake-up via the WAKE pin

The device monitors the WAKE pin and can be configured to respond on a rising and/or falling edge:

- A WPR interrupt is generated on a rising edge if WPRE = 1 (see <u>Table 37</u>)
- A WPF interrupt is generated on a falling edge if WPFE = 1 (see Table 37)

A local wake-up request is registered when the logic level on pin WAKE changes and the new level remains stable for at least  $t_{wake}$ .  $t_{wake}$  is configured via bit WFC in <u>Table 36</u>. The WAKE pin status can be read via bit WPS in the System status register (<u>Table 18</u>). The GPIO pins on the TJA1445B can also be configured as V<sub>IO</sub> level wake pins (see <u>Section 7.8</u>).

## 7.3 CAN operating modes

<u>Table 11</u> contains a summary of the CAN finite state machine (FSM\_CAN) operating modes. A mode transition diagram is shown in <u>Figure 5</u>. Abbreviations used in the mode transition diagram are defined in <u>Table 12</u>.

| Table 11. CAN opera |   |
|---------------------|---|
| Operating mode      | Description   |
| CAN Off             | The CAN transceiver is off.   |
| CAN Offline         | The CAN transceiver is in a low-power mode, able to react to a wake-up pattern (WUP) on the bus.                        |
| CAN OfflineBias     | The CAN transceiver is in a low-power mode, able to react to a wake-up pattern (WUP) or wake-up frame (WUF) on the bus. |
| CAN ListenOnly      | Only the CAN receiver is active and able to capture a wake-up frame (WUF); the RXD pin reflects the CAN bus status.     |
| CAN Active          | The CAN transceiver is active and able to capture a wake-up frame (WUF).  |

## Table 11. CAN operating modes

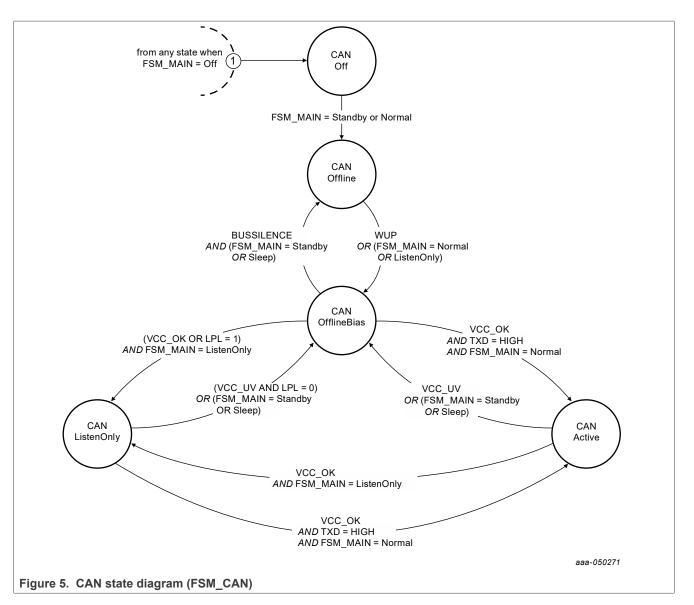
#### Table 12. State diagram legend

| Category       | Abbreviation | Definition                                    |
|----------------|--------------|---|
| CAN bus events | BUSSILENCE   | CAN bus idle for t > t <sub>to(silence)</sub> |
|                | WUP          | valid CAN wake-up pattern detected            |
| VCC pin status | VCC_ОК       | $V_{CC} > V_{uvd(VCC)}$ for t > $t_{rec(uv)}$ |
|                | VCC_UV       | $V_{CC} < V_{uvd(VCC)}$ for t > $t_{det(uv)}$ |

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State transitions are mutually exclusive. FSM\_MAIN = Off condition overrides any transition triggered at the same time, indicated by '1' (priority 1) in <u>Figure 5</u>.

Low-power ListenOnly mode (LPL = 1; see Figure 5 and Table 20) is intended for Pretended Networking use cases and provides CAN listen-only behavior without a  $V_{CC}$  supply. In this mode, the CAN transmitter is switched off to minimize quiescent current and CAN bus biasing is derived from  $V_{BAT}$  (see Table 13). The receiver operates normally.

## 7.3.1 Functional block state per CAN operating mode

| Table 13. | Functional | block state | per CAN | operating mode |
|-----------|------------|-------------|---------|----------------|
|-----------|------------|-------------|---------|----------------|

| Block           | SPI<br>configuration | CAN Off | CAN Offline | CAN Offline<br>Bias | CAN Listen<br>Only | CAN Active            |
|-----------------|----------------------|---------|-------------|---------------------|--------------------|-----------------------|
| CAN transmitter | LPL = 0              | off     | off         | off                 | recessive          | active <sup>[1]</sup> |
|                 | LPL = 1              | off     | off         | off                 | off                | active <sup>[1]</sup> |
| CAN receiver    |                      | off     | off         | off                 | active             | active                |

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| Block    | SPI<br>configuration       | CAN Off | CAN Offline | CAN Offline<br>Bias                    | CAN Listen<br>Only                     | CAN Active         |
|----------|----------------------------|---------|-------------|--|--|--------------------|
| CAN bias | VBATVCC = 1                | high-Z  | GND         | V <sub>CC</sub> /2                     | V <sub>CC</sub> /2                     | V <sub>CC</sub> /2 |
|          | LPL = 0 and<br>VBATVCC = 0 | high-Z  | GND         | 2.5 V derived<br>from V <sub>BAT</sub> | V <sub>CC</sub> /2                     | V <sub>CC</sub> /2 |
|          | LPL = 1 and<br>VBATVCC = 0 | high-Z  | GND         | 2.5 V derived<br>from V <sub>BAT</sub> | 2.5 V derived<br>from V <sub>BAT</sub> | V <sub>CC</sub> /2 |

 Table 13. Functional block state per CAN operating mode...continued

[1] If TXEN\_N is HIGH in TJA1445B, status will be recessive

#### 7.3.2 CAN wake-up

The TJA1445 supports remote wake-up via a CAN wake-up pattern (WUP) or selective wake-up via a CAN wake-up frame (WUF).

## 7.3.2.1 CAN wake-up pattern (WUP)

The CAN wake-up pattern (WUP) is used for two purposes:

- To activate CAN biasing in CAN Offline mode (transition from CAN offline to CAN OfflineBias)
- To trigger a CAN wake-up event

The following conditions must be met to trigger a wake-up event via a CAN WUP:

- The CAN transceiver is in CAN Offline or CAN OfflineBias mode
- CAN wake-up enabled (CWE = 1)
- CAN wake-up frame detection (WUF) deactivated (CPNC = 0 or PNCOK = 0)

The TJA1445 supports both the standard (ISO 11898-2:2024, section 5.5.4) and the extended (ISO 11898-2:2024, section A.4.1) wake-up patterns (see <u>Figure 6</u> and <u>Figure 7</u>). The WUP is selected via bit CWC in the CAN configuration register (<u>Table 20</u>).

The wake-up pattern consists of:

ISO 11898-2:2024, section 5.5.4, standard WUP

- a dominant phase of at least  $t_{wake(busdom)}$  followed by
- a recessive phase of at least  $t_{\mathsf{wake}(\mathsf{busrec})}$  followed by
- a dominant phase of at least t<sub>wake(busdom)</sub>

ISO 11898-2:2024, section A.4.1, WUP extension

standard WUP followed by a recessive phase of at least twake(busrec)

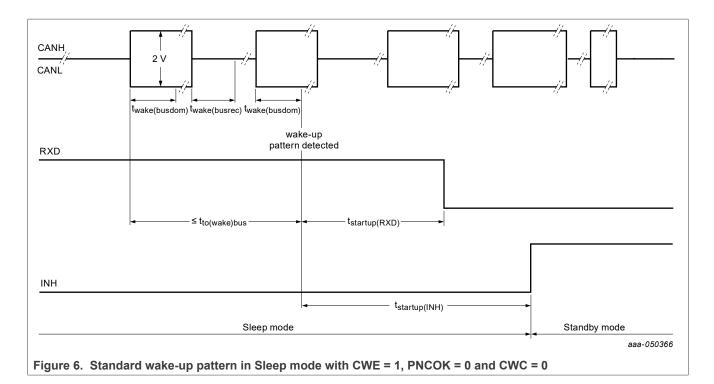
Dominant or recessive bits between the phases shorter than  $t_{wake(busdom)}$  or  $t_{wake(busrec)}$ , respectively, are ignored.

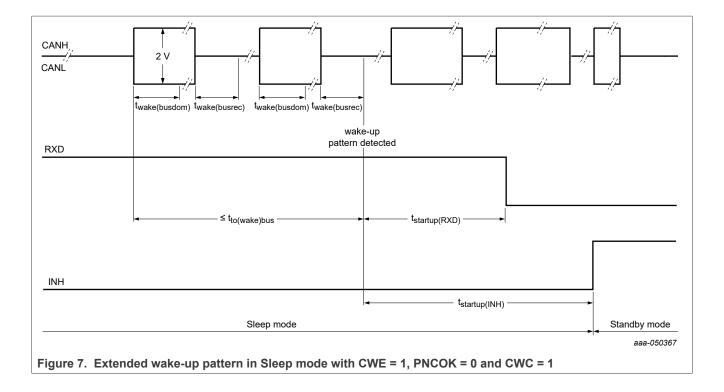
The complete wake-up pattern must be received within  $t_{to(wake)bus}$  to be recognized as a valid wake-up pattern (see Figure 6 and Figure 7). Otherwise, the internal wake-up logic is reset. The complete wake-up pattern then needs to be retransmitted to trigger a wake-up event.

## **NXP Semiconductors**

# **TJA1445**

High-speed CAN transceiver with partial networking





## 7.3.2.2 CAN wake-up frame (WUF)

CAN partial networking through selective wake-up detection allows a device in a CAN network to be selectively woken up in response to a wake-up frame (WUF) on the CAN bus.

Selective wake-up detection uses one of two filtering methods:

- Identifier-only filtering (PNDM = 0)
- Identifier + data length code + data mask filtering (PNDM = 1)

The following conditions must be met to enable CAN WUF functionality:

- CAN biasing needs to be activated (CAN OfflineBias, CAN ListenOnly or CAN Active mode)
- CAN wake-up enabled (CWE = 1)
- CAN partial networking configuration completed (PNCOK = 1)
- CAN partial networking enabled (CPNC = 1)
- No CAN partial networking error detected (CPNERRS = 0)

The PN configuration is defined in the following registers:

- ID registers (Table 29)
- ID mask registers (Table 30)
- Data mask registers (Table 31)
- Frame control register (Table 32)
- Data rate and filter configuration register (Table 33)

Bit PNCOK in the partial networking and CAN configuration register (<u>Table 34</u>) must be set (to 1) to activate the contents of the PN registers. PNCOK is cleared automatically when the contents of any PN register is changed and needs to be set again to load and activate the new configuration.

The arbitration bit rate is selected via bits CDR (see <u>Table 33</u>). CAN bit rates of 50 kbit/s, 100 kbit/s, 125 kbit/s, 250 kbit/s, 500 kbit/s, 667 kbit/s and 1000 kbit/s are supported during selective wake-up.

## 7.3.2.2.1 Identifier matching

The wake-up frame format, standard (11-bit) or extended (29-bit) identifier, is selected via bit IDE in the frame control register (<u>Table 32</u>).

- IDE = 0: standard CBFF (classical base frame format, 11-bit)
- IDE = 1: extended CEFF (classical extended frame format, 29-bit)

A valid WUF identifier is defined and stored in the ID registers (<u>Table 29</u>). An ID mask can be defined to exclude selected bits from being evaluated during WUF detection. The ID mask is defined in the mask registers (<u>Table 30</u>), where a 1 means 'don't care'.

When PNDM = 0, a valid wake-up frame is detected and a wake-up event is captured (CAN wake-up interrupt generated; see <u>Table 40</u>) when:

- the identifier field in the received wake-up frame matches the pattern in the PN ID registers (excluding the masked bits)
- the frame is a valid CBFF or CEFF frame according to the ISO 11898-1:2024 (including CRC and CRC delimiter)

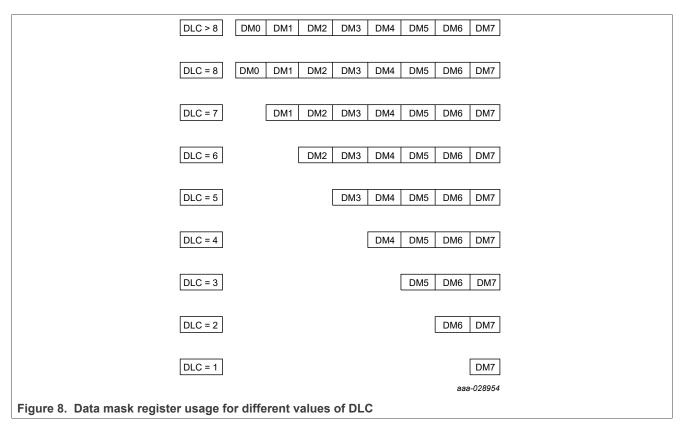
## 7.3.2.2.2 Data field matching

In addition to the identifier field, the data field in the CAN frame is also evaluated during WUF detection when PNDM = 1.

The data field indicates the nodes to be woken up. Within the data field, groups of nodes can be pre-defined and associated with bits in a data mask. By comparing the incoming data field with the data mask, multiple groups of nodes can be woken up simultaneously with a single wake-up message.

The data length code (bits DLC in the frame control register; <u>Table 32</u>) determines the number of data bytes expected (between 0 and 8) in the data field of a CAN wake-up frame. If one or more data bytes are expected (DLC  $\neq$  0000), at least one bit in the data field of the received wake-up frame must be set to 1 and at least one equivalent bit in the associated data mask register in the transceiver (see <u>Table 31</u>) must also be set to 1 for a successful wake-up. Each matching pair of 1s indicates a group of nodes to be activated (since the data field is up to 8 bytes long, up to 64 groups of nodes can be defined).

The relationship between the data mask registers and the data bytes in the CAN message is illustrated in <u>Figure 8</u>. DM7 represents the mask for the last transmitted byte, DM6 for the last-but-one byte and so on.



If DLC = 0000, a node will wake up if the WUF contains a valid identifier and the received data length code is 0000, regardless of the values stored in the data mask (the data field is not evaluated when DLC = 0000). If DLC  $\neq$  0000 and all data mask bits are set to 0, the device cannot be woken up via the CAN bus (note that all data mask bits are set to 1 by default; see <u>Table 31</u>). If a WUF contains a valid ID but the DLCs (in the Frame control register and in the WUF) don't match, the data field is ignored and no nodes are woken up.

Remote frames do not contain data, but request data and can have a DLC  $\neq$  0000; so remote frames are not supported when PNDM = 1. If remote frames need to trigger a wake-up, identifier-only filtering should be selected (PNDM = 0).

When PNDM = 1, a WUF is detected when all the following conditions are met:

- The identifier field in the received wake-up frame matches the pattern and format in the ID registers (<u>Table 29</u>), excluding masked bits.
- The received CAN frame is not a Remote frame.
- The received data length code matches the DLC setting in the frame control register (Table 32).
- DLC:
  - **–** DLC = 0000 or
  - DLC ≠ 0000 and at least one bit in the data field of the received frame is set with the corresponding bit in the associated data mask register (<u>Table 31</u>) also set.
- The frame is a valid CBFF or CEFF frame according to the ISO 11898-1:2024 (including CRC and CRC delimiter).

## 7.3.2.2.3 WUF error processing

If the TJA1445 receives a CAN message containing a protocol error (e.g. a 'stuffing error') transmitted in advance of the ACK field, an internal error counter is incremented. If a classical CAN message (CBFF or CEFF) is received without any errors appearing in front of the ACK field, the counter is decremented. Data received after the CRC delimiter and before the next SOF is ignored by the CAN wake-up frame detector module. If the counter overflows (counter > 31), a frame detect error is captured (PNFDER = 1) and the device wakes up.

The error counter value can be read via bits PN\_ERR\_ERROR\_COUNT (<u>Table 28</u>). The counter is reset to zero when no activity is detected on the CAN bus for  $t_{to(silence)}$  or selective wake-up detection is disabled (CPNC = 0 OR PNCOK = 0). The status, whether the last frame was decoded successfully, can be determined via bit LFDS in the partial networking status register (<u>Table 27</u>).

If selective wake-up is disabled (CPNC = 0) or partial networking is not configured (PNCOK = 0), wake-up will be performed as described in <u>Section 7.3.2.1</u>.

## 7.3.2.2.4 CAN FD passive

CAN frames in the ISO 11898-1:2024 compliant FD base frame format (FBFF) or FD extended frame format (FEFF) are not supported for selective wake-up. The device can be configured to tolerate these frames or treat them as invalid frames via bit PNECC in the partial networking control register (<u>Table 34</u>).

With PNECC = 0, the error counter is incremented when an FBFF or FEFF frame is received. With PNECC = 1, the error counter is not affected because FBFF and FEFF frames are ignored.

CAN FD tolerance as described in the ISO 11898-2 standard is supported for bitfilter 1 and bitfilter 2. The TJA1445 also supports additional bit filter settings for higher arbitration rates up to 1 Mbit/s and data bit rates up to 5 Mbit/s (see bits CDR and IDFS in <u>Table 33</u> and t<sub>fltr(bit)dom</sub> in <u>Table 50</u>).

## 7.4 Interrupt processing

A number of events can be captured and reported to the host via the interrupt mechanism. Pin RXD is used to signal an interrupt event in Standby or Sleep mode. Two options are supported:

- RXDINTC = 0: RXD goes LOW when a wake-up or power-on interrupt is pending
- RXDINTC = 1: RXD goes LOW when any interrupt is pending

Interrupts are enabled individually via dedicated bits in the interrupt enable registers (see <u>Section 7.10.10</u>). When an interrupt is generated, pin RXD goes LOW to alert the host. The host can then determine which event triggered the interrupt by polling the interrupt status registers. PO and PNFDER interrupts are always enabled; so they do not have associated interrupt enable bits.

Interrupts are cleared by writing 1 (W1C) to the relevant interrupt status bits. Clearing an interrupt does not necessarily mean the event that triggered the interrupt has been resolved. If there is a collision, setting the interrupt takes precedence over clearing the interrupt.

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## 7.5 Device ID

A byte is reserved in the register map for the unique device identification code; see bit IDS in Table 46.

## 7.6 Lock control

Sections of the register address area can be write-protected to prevent unintended modifications. Note that this facility only protects locked bits from being modified via the SPI and will not prevent the TJA1445 updating registers. Sections that can be locked are detailed in <u>Section 7.10.11</u>.

## 7.7 General-purpose memory

The TJA1445 allocates 4 bytes of memory to store user information. The general-purpose registers can be accessed via the SPI at address 0xFF0 to 0xFF3 (see <u>Section 7.10.12</u>). The general-purpose registers are only cleared when the battery is first connected.

## 7.8 GPIO pins - TJA1445B only

The TJA1445B contains three general-purpose I/O pins (GPIO) that can be assigned to a number of functions (see <u>Table 14</u> and <u>Table 24</u> to <u>Table 26</u>).

| GPIO function  | Description  |
|--|--|
| Digital input  | pin status can be read via GPIOxS  |
| Digital output   | output polarity defined via GPPx   |
| TXEN_N input   | CAN transmitter disabled when GPIO pin driven HIGH   |
| INT_N interrupt output                                       | active state signals an interrupt is pending   |
| Additional RXD output (RXD2)                                 | <ul> <li>GPIO1 only, two options:</li> <li>CAN bus forwarded to both RXD and RXD2 (via GPIO1) outputs</li> <li>CAN bus forwarded to RXD2 only; RXD forced HIGH in Listen Only and Normal modes; pin RXD behavior in all other modes as in <u>Table 9</u></li> </ul>          |
| Additional TXD input (TXD2)                                  | <ul> <li>GPIO2 only, two options:</li> <li>TXD and TXD2 (via GPIO2) data fed to the CAN bus - the CAN bus will be recessive only when both TXD and TXD2 are HIGH</li> <li>only TXD2 enabled (TXD input ignored) - the CAN bus is driven dominant when TXD2 is LOW</li> </ul> |
| V <sub>CC</sub> undervoltage status output                   | active state indicates V <sub>CC</sub> undervoltage detected (UVCCS)   |
| TXD dominant status output                                   | active state indicates TXD clamped dominant (TXDDOMS)  |
| TXD2 dominant status output                                  | active state indicates TXD2 clamped dominant (TXD2DOMS) - GPIO1 and GPIO3 only   |
| CAN WUP detect status output                                 | active state indicates WUP detected  |
| CAN WUF detect status output                                 | active state indicates WUF detected  |
| CAN bus biasing status output                                | active state indicates bus biasing is active   |
| WAKE pin rising edge detect output                           | active state indicates rising edge detected on WAKE pin  |
| WAKE pin falling edge detect output                          | active state indicates falling edge detected on WAKE pin   |
| CAN in Active mode and ready to transmit status output (CTS) | active state if CAN in Active mode   |

 Table 14. Configurable GPIO functions

| Table 14. Configurable GPIO functionscontinued |  |  |  |
|--|--|--|--|
| GPIO function                                  | Description  |  |  |
| CAN in ListenOnly mode status<br>output        | active state if CAN in ListenOnly mode               |  |  |
| Local low-voltage wake-up input                | wake-up on rising, falling or both edges on GPIO pin |  |  |
| INH2: low-voltage inhibit output               | active state if INH2 activated                       |  |  |

 Table 14. Configurable GPIO functions ...continued

The status of the GPIO pins, HIGH or LOW, can be read (after  $t_{fltr(GPIO)}$ ) via bits GPIOxS in the GPIO status register (<u>Table 23</u>), independently of the selected function.

When an input function is selected, the pin behavior can be configured as:

- floating
- pull-up
- pull-down
- repeater

When an output function is selected, the pin output driver can be configured as:

- push-pull
- open-drain high-side driver
- high-side driver plus weak pull-down
- open-drain low-side driver
- · low-side driver plus weak pull-up

For selected output functions, the GPIO pins can be configured as active-HIGH or active-LOW (see <u>Table 22</u>). The minimum pulse width when GPIO is configured as output is greater than  $t_{w(min)}$ .

## 7.9 Failure handling

The TJA1445 incorporates a number of safety features used for error detection and processing.

## 7.9.1 TXD dominant timeout

A LOW level on pin TXD (or on GPIO2 in TJA1445B when configured as a second TXD input, see Section 7.8) persisting longer than  $t_{to(dom)TXD}$  releases the bus lines to recessive state. This feature prevents the CAN bus being blocked by continuous dominant clamping. A CAN failure interrupt is generated (TXDDOM/TXD2DOM = 1), if enabled (TXDDOME/TXD2DOME = 1), when a TXD dominant timeout is detected. The TXD dominant status can be read via bit TXDDOMS/TXD2DOMS in the CAN status register (Table 21).

## 7.9.2 CAN transmitter enable/disable(TXEN\_N) - TJA1445B only

On the TJA1445B, the CAN transmitter can be enabled/disabled via the TXEN\_N input. The GPIO pins can be configured as additional transmitter enable/disable signals (see <u>Section 7.8</u>). A HIGH level on pin TXEN\_N, or on a GPIO pin configured as a TXEN\_N input, disables the transmitter, releasing the bus lines to recessive state independent of the level on pin TXD and/or TXD2 (if configured on GPIO2). The TXEN\_N status can be read via bit GPIO1S, GPIO2S and GPIO3S in the GPIO status register (<u>Table 23</u>).

## 7.9.3 Bus dominant timeout

A dominant state on the CAN bus lasting longer than  $t_{to(dom)bus}$  generates a CAN bus failure interrupt (BUSDOM = 1), if enabled (BUSDOME = 1; <u>Table 38</u>). The status of the bus can be read via bit BUSDOMS in

the CAN status register (<u>Table 21</u>). Note that this feature is only available in Normal mode and in Listen Only modes when LPL = 0.

## 7.9.4 V<sub>CC</sub> undervoltage

The TJA1445 monitors the supply voltage on pin VCC. When V<sub>CC</sub> drops below the undervoltage detection threshold V<sub>uvd(VCC)</sub> for longer than t<sub>det(uv)</sub>, a V<sub>CC</sub> undervoltage interrupt is generated (UVCC = 1), if enabled (UVCCE = 1; <u>Table 37</u>). The V<sub>CC</sub> undervoltage status can be read via bit UVCCS in the system status register (<u>Table 18</u>).

## 7.9.5 V<sub>IO</sub> undervoltage

The TJA1445 monitors the supply voltage on pin VIO. When  $V_{IO}$  drops below the undervoltage detection threshold  $V_{uvd(VIO)}$  for longer than  $t_{det(uv)long}$ , the device switches to Sleep mode by setting mode control bits MC to Sleep. Pending wake-up interrupts are cleared and the wake-up sources are enabled (bits CWE, WPRE and WPFE set). The TJA1445 then waits for a wake-up request.

A long VIO undervoltage interrupt is generated (LUVIO = 1), if enabled (LUVIOE = 1; see <u>Table 18</u>). On recovering from an undervoltage event, the TJA1445 switches back to the selected mode (MC). Note that a long undervoltage event on VIO (LUVIO) will not be captured in Sleep mode.

The long undervoltage detection time,  $t_{det(uv)long}$ , is selected via bit LUVIOSEL in the system configuration register (<u>Table 19</u>).

## 7.9.6 V<sub>BAT</sub> undervoltage

The TJA1445 monitors the supply voltage on pin VBAT. It switches directly to Off mode when  $V_{BAT}$  drops below the undervoltage detection threshold,  $V_{uvd(VBAT)}$  for  $t_{det(uv)}$ . As a consequence, bit PO is set (see <u>Table 40</u>).

#### 7.9.7 Overtemperature

The TJA1445 only monitors the junction temperature when MC = Normal. When the junction temperature exceeds  $T_{j(sd)}$ , the device switches from Normal mode to ListenOnly mode (see Section 7.2). An overtemperature interrupt is generated (OT = 1), if enabled (OTE = 1; see Table 40). The device recovers and switches back to Normal mode when the junction temperature falls below the shutdown release threshold,  $T_{j(sd)rel}$ . The overtemperature status can be read via bit OTS in the system status register (Table 18) when the device is in Normal or ListenOnly mode.

#### 7.9.8 MCU reaction timeout

When the TJA1445 enters Standby mode from Sleep mode due to a wake-up or from Check\_SNM mode, the MCU reaction timeout timer is started.

If a valid SPI frame is detected within  $t_{to(MCU)}$ , the MCU reaction timer is reset. If a valid SPI frame is not detected within  $t_{to(MCU)}$ , an MCU reaction timeout is triggered and the device switches to Sleep mode by setting mode control bits MC to Sleep. Pending wake-up interrupts are cleared and the wake-up sources are enabled (bits CWE, WPRE and WPFE set). The TJA1445 then waits for a wake-up request.

The MCU reaction timeout time depends on the long undervoltage threshold, selected via bit LUVIOSEL in the system configuration register (<u>Table 19</u> and <u>Table 50</u>).

## 7.10 SPI interface

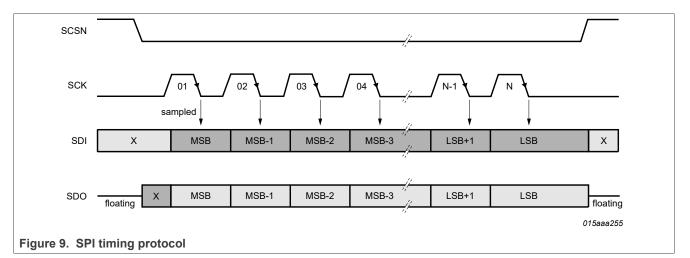
The serial peripheral interface (SPI) provides the communication link with the microcontroller. The SPI is configured for full duplex data transfer, so status information is returned when new control data is shifted in.

The interface also offers a read-only access option, allowing registers to be read back by the application without changing the register content.

The SPI uses four interface signals for synchronization and data transfer:

- SCSN: SPI chip select; active LOW
- SCK: SPI clock
- SDI: SPI data input
- SDO: SPI data output; floating when pin SCSN is HIGH (may need external pull-up or pull-down if not available in the host controller)

Bit sampling is performed on the falling edge of the clock and data is shifted in/out on the rising edge, as illustrated in <u>Figure 9</u>.



The SPI data in the TJA1445 is stored in a number of dedicated 8-bit registers. Each register is assigned a unique 12-bit address. A minimum of three bytes (24 bits) must be transmitted to the TJA1445 for a single register read or write operation (see Figure 9). Six bytes (48 bits) are needed to transmit the maximum of 4 data bytes (see Figure 10).

The first byte contains the 8 most significant bits of the address; the second byte contains the 4 least significant bits of the address, a 'read-only' bit, a 2-bit payload size (PLS) and a parity bit. The read-only bit must be 0 to indicate a write operation and 1 to indicate a read operation. PLS indicates the number of data bytes being transmitted:

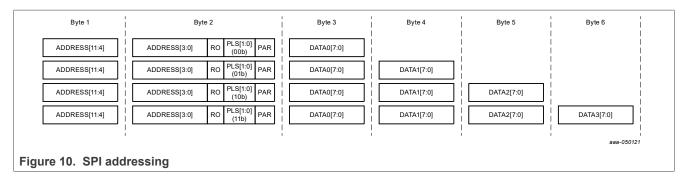
- 00 1 data byte
- 01 2 data bytes
- 10 3 data bytes
- 11 4 data bytes

The parity bit covers the address bits, read-only bit and PLS bits. It must be calculated in the user application as part of the SPI command indicating even parity, creating an even number of 1s in the first 2 bytes including the parity bit.

The third and subsequent bytes contain the data to be written. For two or more data bytes (PLS  $\neq$  00), the register address is incremented automatically after each data byte, see <u>Figure 10</u>.

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During the SPI data, read or write operation, the first 15 bits received on pin SDI are returned via pin SDO; bit 16 returns the parity calculated for these 15 bits. During the data phase of the SPI protocol, the contents of the addressed register is returned via the SDO pin.

The devices tolerates write attempts to registers that do not exist.

## 7.10.1 SPI error handling

The TJA1445 can detect a number of SPI transmission failures:

- an incorrect parity bit was received
- the number of clock cycles is less than 24 or does not match the expected value based on the PLS
- an address rollover (> FFFh) was detected
- an undefined MC code was received
- a write access was attempted to a locked register
- the SPI message was not completed (SCSN HIGH) within the timeout time,  $t_{to(SPI)}$

In all cases, an SPI fail interrupt is generated (provided SPIFE = 1) and the entire message is ignored.

When the necessary conditions for a Sleep mode transition (no wake-up source enabled or pending wake-up interrupt) are not met, the device will not switch to sleep mode, even though MC = 0001.

In the case of an incorrect parity or too many clock cycles, pin SDO goes LOW until the next rising edge on SCSN. When the duration of the SPI message exceeds  $t_{to(SPI)}$ , the SDO pin goes high-Z.

#### 7.10.2 SPI system reset

A system reset can be forced via the SPI, causing the device to restart via Boot mode and setting bit PO. To trigger a system reset, enable SPI write access to the System reset register by setting LKRST to 0 in the Lock control register; then write consecutively 0x01 followed 0x80 to bits SFR in the System reset register (see <u>Table 35</u>). Both SPI accesses to the System reset register should be 24-bit. Any deviation from this sequence will abort the system reset.

Information that was in the general-purpose memory (<u>Table 45</u>) when the reset was initiated will still be available after the reset sequence has been completed.

## 7.10.3 SPI register map

#### Table 15. SPI register map overview

| Register type           | Address | Register name  |
|-------------------------|---------|--|
| Mode control            | 0x000   | Mode control register  |
| Interrupt enable (LKIE) | 0x010   | System interrupt enable register                               |
|                         | 0x011   | CAN interrupt enable register                                  |
|                         | 0x012   | GPIO interrput enable register - TJA1445B only                 |
| Partial networking      | 0x020   | Partial networking ID register 0                               |
| (LKPNC)                 | 0x021   | Partial networking ID register 1                               |
|                         | 0x022   | Partial networking ID register 2                               |
|                         | 0x023   | Partial networking ID register 3                               |
|                         | 0x024   | Partial networking ID mask register 0                          |
|                         | 0x025   | Partial networking ID mask register 1                          |
|                         | 0x026   | Partial networking ID mask register 2                          |
|                         | 0x027   | Partial networking ID mask register 3                          |
|                         | 0x028   | Partial networking data mask register 0                        |
|                         | 0x029   | Partial networking data mask register 1                        |
|                         | 0x02A   | Partial networking data mask register 2                        |
|                         | 0x02B   | Partial networking data mask register 3                        |
|                         | 0x02C   | Partial networking data mask register 4                        |
|                         | 0x02D   | Partial networking data mask register 5                        |
|                         | 0x02E   | Partial networking data mask register 6                        |
|                         | 0x02F   | Partial networking data mask register 7                        |
|                         | 0x030   | Partial networking frame control register                      |
|                         | 0x031   | Partial networking data rate and filter configuration register |
|                         | 0x032   | Partial networking and CAN configuration register              |
| Configuration (LKCFG)   | 0x040   | Wake-up pulse configuration register                           |
|                         | 0x041   | CAN configuration register                                     |
|                         | 0x042   | GPIO1 configuration register - TJA1445B only                   |
|                         | 0x043   | GPIO2 configuration register - TJA1445B only                   |
|                         | 0x044   | GPIO3 configuration register - TJA1445B only                   |
|                         | 0x045   | GPIO polarity configuration register - TJA1445B only           |
|                         | 0x046   | System configuration register                                  |
| Lock                    | 0x050   | Lock control register  |
| Interrupt status        | 0x060   | System interrupt status register                               |
|                         | 0x061   | CAN interrupt status register                                  |
|                         | 0x062   | Partial networking interrupt status register                   |
|                         | 0x063   | GPIO interrupt status register - TJA1445B only                 |

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| Register type          | Address | Register name                                  |
|------------------------|---------|--|
| General status         | 0x070   | Mode status register                           |
|                        | 0x071   | System status register                         |
|                        | 0x072   | CAN status register                            |
|                        | 0x073   | Partial networking status register             |
|                        | 0x074   | GPIO/TXEN_N status register - TJA1445B only    |
|                        | 0x075   | Partial networking error count status register |
| Reset (LKRST)          | 0xFE0   | System reset register                          |
| General-purpose memory | 0xFF0   | General-purpose memory register 0              |
| (LKGPM)                | 0xFF1   | General-purpose memory register 1              |
|                        | 0xFF2   | General-purpose memory register 2              |
|                        | 0xFF3   | General-purpose memory register 3              |
| ID                     | 0xFFF   | Device identification                          |

Table 15. SPI register map overview...continued

## 7.10.4 System control and status registers

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '\*'.

| Bit | Symbol   | Access | Value               | Description                       |  |
|-----|----------|--------|---------------------|-----------------------------------|--|
| 7:4 | reserved | R      | -                   | always write 0000; ignore on read |  |
| 3:0 | MC       | R/W    | 0001 <sup>[1]</sup> | Sleep mode                        |  |
|     |          |        | 0110*               | Standby mode                      |  |
|     |          |        | 1000                | ListenOnly mode                   |  |
|     |          |        | 1111 <sup>[2]</sup> | Normal mode                       |  |

Table 16. Mode control register (address 000h)

Value when Sleep mode is entered due to expiration of VIO\_UV\_LONG or MCU\_REAC\_EXP.
 Value after Check\_SNM-to-Normal mode transition

#### Table 17. Mode status register (address 070h)

| Bit | Symbol   | Access | Value | Description     |  |
|-----|----------|--------|-------|-----------------|--|
| 7:4 | reserved | R      | -     | ignore on read  |  |
| 3:0 | MCS      | R      | 0001  | Sleep mode      |  |
|     |          |        | 0110  | Standby mode    |  |
|     |          |        | 1000  | ListenOnly mode |  |
|     |          |        | 1111  | Normal mode     |  |

#### Table 18. System status register (address 071h)

| Bit     | Symbol   | Access | Value | Description  |                                      |
|---------|----------|--------|-------|--|--------------------------------------|
| 7       | reserved | R      | -     | ignore on read   |                                      |
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| Bit | Symbol   | Access | Value | Description  |
|-----|----------|--------|-------|--|
| 6   | FSMS     | R      |       | most recent Sleep mode transition:   |
|     |          |        | 0     | triggered by SPI   |
|     |          |        | 1     | triggered by VIO undervoltage or MCU timeout                                   |
| 5   | OTS      | R      |       | overtemperature status available when MC = Normal and MCS = Normal/Listen Only |
|     |          |        | 0     | no overtemperature or MC ≠ Normal  |
|     |          |        | 1     | overtemperature detected   |
| 4   | reserved | R      | -     | ignore on read   |
| 3   | UVCCS    | R      |       | V <sub>CC</sub> undervoltage status  |
|     |          |        | 0     | no undervoltage on VCC   |
|     |          |        | 1     | V <sub>CC</sub> undervoltage detected  |
| 2   | NMS      | R      |       | Normal mode status   |
|     |          |        | 0     | device entered Normal mode after power up                                      |
|     |          |        | 1     | device did not enter Normal mode power up                                      |
| 1   | SNMS     | R      |       | Start-to-Normal mode status  |
|     |          |        | 0     | device did not enter Normal mode after power up                                |
|     |          |        | 1     | device entered Normal mode directly from Check_SNM mode                        |
| 0   | WPS      | R      |       | WAKE pin status  |
|     |          |        | 0     | WAKE pin LOW   |
|     |          |        | 1     | WAKE pin HIGH  |

 Table 18. System status register (address 071h)...continued

## Table 19. System configuration register (address 046h)

| Bit | Symbol   | Access | Value | Description  |
|-----|----------|--------|-------|--|
| 7:4 | reserved | R      | -     | always write 0000; ignore on read  |
| 3   | BCCTRL   | R/W    |       | VBAT clamp control:  |
|     |          |        | 0*    | enable VBAT clamp  |
|     |          |        | 1     | disable VBAT clamp   |
| 2   | RXDINTC  | R/W    |       | interrupt signaling at RXD in Sleep/Standby modes  |
|     |          |        | 0*    | wake-up and power-on interrupts detected   |
|     |          |        | 1     | all enabled interrupts detected  |
| 1   | LUVIOSEL | R/W    |       | long VIO undervoltage detection time and MCU reaction timeout time select                          |
|     |          |        | 0     | t <sub>det(uv)long1</sub> , t <sub>to(MCU)1</sub>  |
|     |          |        | 1*    | t <sub>det(uv)long2</sub> , t <sub>to(MCU)2</sub>  |
| 0   | VBATVCC  | R/W    |       | VBAT/VCC configuration   |
|     |          |        | 0*    | separate $V_{BAT}$ and $V_{CC}$ supplies; typical application; autobiasing supplied from $V_{BAT}$ |

| Bit | Symbol | Access | Value | Description   |
|-----|--------|--------|-------|---|
|     |        |        | 1     | common $V_{BAT}$ and $V_{CC}$ supplies; applications with permanently active regulator; autobiasing is supplied from $V_{CC}$ |

#### Table 19. System configuration register (address 046h)...continued

## 7.10.5 CAN configuration and status registers

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '\*'.

| Bit | Symbol                       | Access | Value | Description  |
|-----|------------------------------|--------|-------|--|
| 7:6 | reserved                     | R      | -     | always write 00; ignore on read  |
| 5   | TXRXLP                       | R/W    |       | TXD-to-RXD loopback:   |
|     |                              |        | 0*    | normal TXD and RXD behavior  |
|     |                              |        | 1     | TXD is forwarded to RXD and CAN bus remains recessive in CAN Active mode   |
| 4   | reserved:<br><i>TJA1445A</i> | R      | -     | always write 0; ignore on read   |
| 4   | TX2RX2LP <sup>[1]</sup>      | R/W    |       | TXD2-to-RXD2 loopback:   |
|     | TJA1445B                     |        | 0*    | normal TXD2 and RXD2 behavior  |
|     |                              |        | 1     | TXD2 is forwarded to RXD2 and CAN bus remains recessive in CAN Active mode |
| 3:2 | reserved                     | R      | -     | always write 00; ignore on read  |
| 1   | LPL                          | R/W    |       | low-power ListenOnly mode enable:  |
|     |                              |        | 0*    | low-power ListenOnly mode disabled   |
|     |                              |        | 1     | low-power ListenOnly mode enabled  |
| 0   | CWC                          | R/W    |       | CAN wake-up pattern selection:   |
|     |                              |        | 0*    | ISO 11898-2:2024 wake pattern (dom-rec-dom)                                |
|     |                              |        | 1     | ISO 11898-2:2024 wake pattern (dom-rec-dom-rec)                            |

Table 20. CAN configuration register (address 041h)

[1] GPIO1 configured as second RXD output (RXD2) and GPIO2 configured as second TXD input (TXD2).

| Bit | Symbol   | Access | Value | Description   |
|-----|----------|--------|-------|---|
| 7   | CTS      | R      |       | CAN transceiver status:                                       |
|     |          |        | 0     | CAN transceiver not in Active mode or not ready to transmit   |
|     |          |        | 1     | CAN transceiver in Active mode and ready to transmit          |
| 6:4 | reserved | R      | -     | ignore on read  |
| 3   | CBSS     | R      |       | CAN bus silence status:                                       |
|     |          |        | 0     | no bus silence longer than $t_{\text{to(silence)}}$ detected  |
|     |          |        | 1     | bus silence detected for longer than t <sub>to(silence)</sub> |

Table 21. CAN status register (address 072h)

| Bit | Symbol                       | Access | Value | Description                   |
|-----|------------------------------|--------|-------|-------------------------------|
| 2   | BUSDOMS                      | R      |       | BUS clamped dominant status:  |
|     |                              |        | 0     | CAN bus not clamped dominant  |
|     |                              |        | 1     | CAN bus clamped dominant      |
| 1   | reserved:<br><i>TJA1445A</i> | R      | -     | ignore on read                |
| 1   | TXD2DOMS                     | R      |       | TXD2 clamped dominant status: |
|     | TJA1445B                     |        | 0     | TXD2 not clamped dominant     |
|     |                              |        | 1     | TXD2 clamped dominant         |
| 0   | TXDDOMS                      | R      |       | TXD clamped dominant status:  |
|     |                              |        | 0     | TXD not clamped dominant      |
|     |                              |        | 1     | TXD clamped dominant          |

 Table 21. CAN status register (address 072h)...continued

## 7.10.6 GPIO configuration and status registers: TJA1445B only

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '\*'.

| Bit | Symbol   | Access | Value | Description                        |
|-----|----------|--------|-------|------------------------------------|
| 7:3 | reserved | R      | -     | always write 00000; ignore on read |
| 2   | GPP3     | R/W    |       | GPIO3 polarity:                    |
|     |          |        | 0*    | default polarity                   |
|     |          |        | 1     | inverted polarity                  |
| 1   | GPP2 F   | R/W    |       | GPIO2 polarity:                    |
|     |          |        | 0*    | default polarity                   |
|     |          |        | 1     | inverted polarity                  |
| 0   | GPP1     | R/W    |       | GPIO1 polarity: <sup>[1]</sup>     |
|     |          |        | 0*    | default polarity                   |
|     |          |        | 1     | inverted polarity                  |

Table 22. GPIO output polarity configuration register (address 045h)

[1] n.a when when GPIO1 is configured as RXD2.

| Bit | Symbol   | Access | Value | Description        |  |
|-----|----------|--------|-------|--------------------|--|
| 7:4 | reserved | R      | -     | ignore on read     |  |
| 3   | TXENS    | R      |       | TXEN_N pin status: |  |
|     |          |        | 0     | TXEN_N LOW         |  |
|     |          |        | 1     | TXEN_N HIGH        |  |
| 2   | GPIO3S   | R      |       | GPIO3 pin status:  |  |
|     |          |        | 0     | GPIO3 LOW          |  |

Table 23. GPIO/TXEN\_N status register (address 074h)

| Bit | Symbol | Access | Value | Description       |
|-----|--------|--------|-------|-------------------|
|     |        |        | 1     | GPIO3 HIGH        |
| 1   | GPIO2S | R      |       | GPIO2 pin status: |
|     |        |        | 0     | GPIO2 LOW         |
|     |        |        | 1     | GPIO2 HIGH        |
| 0   | GPIO1S | R      |       | GPIO1 pin status: |
|     |        |        | 0     | GPIO1 LOW         |
|     |        |        | 1     | GPIO1 HIGH        |

#### Table 23. GPIO/TXEN\_N status register (address 074h)...continued

#### Table 24. GPIO1 configuration register (address 042h)

| Bit | Symbol  | Access | Value        | Description  |
|-----|---------|--------|--------------|--|
| 7:5 | GPIO1C  | R/W    |              | GPIO1 pin configuration:   |
|     |         |        | 000          | input: floating<br>output: push-pull   |
|     |         |        | 001          | input: pull-up<br>output: open-drain high-side driver  |
|     |         |        | 010          | input: pull-down<br>output: high-side driver plus weak pull-down                             |
|     |         |        | 011*         | input: repeater<br>output: open-drain low-side driver  |
|     |         |        | 100          | input: repeater<br>output: low-side driver plus weak pull-up                                 |
|     |         |        | 101 -<br>111 | reserved   |
| 4:0 | GPIO1FS | R/W    |              | GPIO1 function select:   |
|     |         |        | 0x00*        | repeater function active, independent of GPIO1C  |
|     |         |        | 0x01         | digital input  |
|     |         |        | 0x02         | digital output: LOW when GPP1 = 0; HIGH when GPP1 = 1  |
|     |         |        | 0x03         | TXEN_N input; CAN transmitter disabled when GPIO pin driven HIGH                             |
|     |         |        | 0x04         | INT_N interrupt output; active-LOW when GPP1 = 0 (default); active-HIGH when GPP1 = 1        |
|     |         |        | 0x05         | reserved   |
|     |         |        | 0x06         | GPIO1 configured as second RXD output (RXD2); CAN bus forwarded to both GPIO1 (RXD2) and RXD |
|     |         |        | 0x07         | reserved   |
|     |         |        | 0x08         | GPIO1 configured as second RXD output (RXD2); CAN bus only forwarded to GPIO1 (RXD2)         |
|     |         |        | 0x09         | V <sub>CC</sub> undervoltage status output (UVCCS) <sup>[1]</sup>                            |
|     |         |        | 0x0A         | TXD dominant status output (TXDDOMS) <sup>[1]</sup>  |

| Bit | Symbol | Access | Value           | Description   |
|-----|--------|--------|-----------------|---|
|     |        |        | 0x0B            | TXD2 dominant status output (TXD2DOMS; available when GPIO2 configured as TXD2) <sup>[1]</sup>            |
|     |        |        | 0x0C            | wake-up pattern detect output <sup>[1]</sup>  |
|     |        |        | 0x0D            | wake-up frame detect output <sup>[1]</sup>  |
|     |        |        | 0x0E            | CAN bus biasing status output (HIGH, by default, indicates that CAN bus biasing is active) <sup>[1]</sup> |
|     |        |        | 0x0F            | WAKE pin rising edge detect output <sup>[1]</sup>   |
|     |        |        | 0x10            | WAKE pin falling edge detect output <sup>[1]</sup>  |
|     |        |        | 0x11            | CAN Active mode ready-to-transmit status output (CTS) <sup>[1]</sup>                                      |
|     |        |        | 0x12            | CAN ListenOnly mode status output <sup>[1]</sup>  |
|     |        |        | 0x13            | digital input, rising edge qualified for wake-up interrupt if enabled via GPIO1E                          |
|     |        |        | 0x14            | digital input, falling edge qualified for wake-up interrupt if enabled via GPIO1E                         |
|     |        |        | 0x15            | digital input, rising and falling edge qualified for wake-up interrupt if enabled via GPIO1E              |
|     |        |        | 0x16            | INH2 output <sup>[1]</sup>  |
|     |        |        | 0x17 to<br>0x1F | reserved  |

 Table 24. GPIO1 configuration register (address 042h)...continued

[1] Active-HIGH when GPP1 = 0; active-LOW when GPP1 = 1

#### Table 25. GPIO2 configuration register (address 043h)

| Bit | Symbol  | Access | Value        | Description  |  |
|-----|---------|--------|--------------|--|--|
| 7:5 | GPIO2C  | R/W    |              | GPIO2 pin configuration:   |  |
|     |         |        | 000          | input: floating<br>output: push-pull                             |  |
|     |         |        | 001          | input: pull-up<br>output: open-drain high-side driver            |  |
|     |         |        | 010          | input: pull-down<br>output: high-side driver plus weak pull-down |  |
|     |         |        | 011*         | input: repeater<br>output: open-drain low-side driver            |  |
|     |         |        | 100          | input: repeater<br>output: low-side driver plus weak pull-up     |  |
|     |         |        | 101 -<br>111 | reserved   |  |
| 4:0 | GPIO2FS | R/W    |              | GPIO2 function select:   |  |
|     |         |        | 0x00*        | repeater function active, independent of GPIO2C                  |  |
|     |         |        | 0x01         | digital input  |  |
|     |         |        | 0x02         | digital output: LOW when GPP2 = 0; HIGH when GPP2 = 1            |  |
|     |         |        | 0x03         | TXEN_N input; CAN transmitter disabled when GPIO pin driven HIGH |  |

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| Bit | Symbol | Access | Value           | Description   |
|-----|--------|--------|-----------------|---|
|     |        |        | 0x04            | INT_N interrupt output; active-LOW when GPP2 = 0 (default); active-HIGH when GPP2 = 1                         |
|     |        |        | 0x05            | GPIO2 configured as second TXD input (TXD2); TXD and TXD2 (via GPIO2) data fed to the CAN bus                 |
|     |        |        | 0x06            | reserved  |
|     |        |        | 0x07            | GPIO2 configured as second TXD input (TXD2); only TXD2 (via GPIO2) data fed to the CAN bus; TXD input ignored |
|     |        |        | 0x08            | reserved  |
|     |        |        | 0x09            | V <sub>CC</sub> undervoltage status output (UVCCS) <sup>[1]</sup>   |
|     |        |        | 0x0A            | TXD dominant status output (TXDDOMS) <sup>[1]</sup>   |
|     |        |        | 0x0B            | reserved  |
|     |        |        | 0x0C            | wake-up pattern detect output <sup>[1]</sup>  |
|     |        |        | 0x0D            | wake-up frame detect output <sup>[1]</sup>  |
|     |        |        | 0x0E            | CAN bus biasing status (HIGH, by default, indicates that CAN bus biasing is active) <sup>[1]</sup>            |
|     |        |        | 0x0F            | WAKE pin rising edge detect output <sup>[1]</sup>   |
|     |        |        | 0x10            | WAKE pin falling edge detect output <sup>[1]</sup>  |
|     |        |        | 0x11            | CAN Active mode ready-to-transmit status output (CTS) <sup>[1]</sup>  |
|     |        |        | 0x12            | CAN ListenOnly mode status <sup>[1]</sup>   |
|     |        |        | 0x13            | digital input, rising edge qualified for wake-up interrupt if enabled via GPIO2E                              |
|     |        |        | 0x14            | digital input, falling edge qualified for wake-up interrupt if enabled via GPIO2E                             |
|     |        |        | 0x15            | digital input, rising and falling edge qualified for wake-up interrupt if enabled via GPIO2E                  |
|     |        |        | 0x16            | INH2 output <sup>[1]</sup>  |
|     |        |        | 0x17 to<br>0x1F | reserved  |

 Table 25. GPIO2 configuration register (address 043h)...continued

[1] Active-HIGH when GPP2 = 0; active-LOW when GPP2 = 1

| Table 26. | GPIO3 | configuration | register | (address 044h) |
|-----------|-------|---------------|----------|----------------|
|-----------|-------|---------------|----------|----------------|

| Bit | Symbol | Access | Value | Description   |  |
|-----|--------|--------|-------|---|--|
| 7:5 | GPIO3C | R/W    |       | GPIO3 pin configuration:         input: floating         output: push-pull         input: pull-up         output: open-drain high-side driver |  |
|     |        |        | 000   |   |  |
|     |        |        | 001   |   |  |
|     |        |        | 010   | input: pull-down<br>output: high-side driver plus weak pull-down  |  |
|     |        |        | 011*  | input: repeater<br>output: open-drain low-side driver   |  |

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| Bit | Symbol  | Access | Value           | Description  |
|-----|---------|--------|-----------------|--|
|     |         |        | 100             | input: repeater<br>output: low-side driver plus weak pull-up                                       |
|     |         |        | 101 -<br>111    | reserved   |
| 4:0 | GPIO3FS | R/W    |                 | GPIO3 function select:   |
|     |         |        | 0x00*           | repeater function active, independent of GPIO3C  |
|     |         |        | 0x01            | digital input  |
|     |         |        | 0x02            | digital output: LOW when GPP3 = 0; HIGH when GPP3 = 1  |
|     |         |        | 0x03            | TXEN_N input; CAN transmitter disabled when GPIO pin driven HIGH                                   |
|     |         |        | 0x04            | INT_N interrupt output; active-LOW when GPP3 = 0 (default); active-HIGH when GPP3 = 1              |
|     |         |        | 0x05            | reserved   |
|     |         |        | 0x06            | reserved   |
|     |         |        | 0x07            | reserved   |
|     |         |        | 0x08            | reserved   |
|     |         |        | 0x09            | V <sub>CC</sub> undervoltage status output (UVCCS) <sup>[1]</sup>                                  |
|     |         |        | 0x0A            | TXD dominant status output (TXDDOMS) <sup>[1]</sup>  |
|     |         |        | 0x0B            | TXD2 dominant status output (TXD2DOMS; available when GPIO2 configured as TXD2) <sup>[1]</sup>     |
|     |         |        | 0x0C            | wake-up pattern detect output <sup>[1]</sup>   |
|     |         |        | 0x0D            | wake-up frame detect output <sup>[1]</sup>   |
|     |         |        | 0x0E            | CAN bus biasing status (HIGH, by default, indicates that CAN bus biasing is active) <sup>[1]</sup> |
|     |         |        | 0x0F            | WAKE pin rising edge detect output <sup>[1]</sup>  |
|     |         |        | 0x10            | WAKE pin falling edge detect output <sup>[1]</sup>   |
|     |         |        | 0x11            | CAN Active mode ready-to-transmit status output (CTS) <sup>[1]</sup>                               |
|     |         |        | 0x12            | CAN ListenOnly mode status <sup>[1]</sup>  |
|     |         |        | 0x13            | digital input, rising edge qualified for wake-up interrupt if enabled via GPIO3E                   |
|     |         |        | 0x14            | digital input, falling edge qualified for wake-up interrupt if enabled via GPIO3E                  |
|     |         |        | 0x15            | digital input, rising and falling edge qualified for wake-up interrupt if enabled via GPIO3E       |
|     |         |        | 0x16            | INH2 output <sup>[1]</sup>   |
|     |         |        | 0x17 to<br>0x1F | reserved   |

 Table 26. GPIO3 configuration register (address 044h)...continued

[1] Active-HIGH when GPP3 = 0; active-LOW when GPP3 = 1

## 7.10.7 Partial networking registers

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '#'.

| Bit | Symbol   | Access | Value | Description  |
|-----|----------|--------|-------|--|
| 7   | SYNCS    | R      |       | CAN partial networking sync status:  |
|     |          |        | 0     | CAN partial networking core not ready to decode frame                                  |
|     |          |        | 1     | CAN partial networking core ready to decode frame                                      |
| 6   | CPNERRS  | R      |       | CAN partial networking error status:   |
|     |          |        | 0     | no CAN partial networking error detected; PNFDER = 0 and PNCOK<br>= 1                  |
|     |          |        | 1     | CAN partial networking error detected; PNFDER =1 or PNCOK = 0;<br>wake-up via WUP only |
| 5   | CPNS     | R      |       | CAN partial networking status:   |
|     |          |        | 0     | CAN partial networking configuration error detected; PNCOK = 0                         |
|     |          |        | 1     | CAN partial networking configuration OK; PNCOK = 1                                     |
| 4   | LFDS     | S R    |       | last frame decode status:  |
|     |          |        |       | most recent CAN frame not decoded successfully   |
|     |          |        | 1     | most recent CAN frame decoded successfully   |
| 3:0 | reserved | R      | -     | ignore on read   |

Table 27. Partial networking status register (address 073h)

#### Table 28. Partial networking error count status register (address 075h)

| Bit | Symbol   | Access | Value | Description                                |
|-----|----------|--------|-------|--|
| 7:5 | reserved | R      | -     | ignore on read                             |
| 4:0 | PNERRCNT | R      |       | CAN partial networking error count status: |
|     |          |        | 00000 | 0  |
|     |          |        | 00001 | 1  |
|     |          |        | 00010 | 2  |
|     |          |        | 00011 | 3  |
|     |          |        |       |  |
|     |          |        | 11111 | 31   |

#### Table 29. Partial networking ID registers 0 to 3 (addresses 020h to 023h)

| Addr. | Bit | Symbol    | Access | Value            | Description  |
|-------|-----|-----------|--------|------------------|--|
| 020h  | 7:0 | ID7:ID0   | R/W    | 00h <sup>#</sup> | bits ID7 to ID0 of the extended frame format   |
| 021h  | 7:0 | ID15:ID8  | R/W    | 00h <sup>#</sup> | bits ID15 to ID8 of the extended frame format  |
| 022h  | 7:2 | ID23:ID18 | R/W    | 00h <sup>#</sup> | bits ID23 to ID18 of the extended frame format<br>bits ID5 to ID0 of the standard frame format |
|       | 1:0 | ID17:ID16 | R/W    | 00h <sup>#</sup> | bits ID17 to ID16 of the extended frame format   |

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| Addr. | Bit | Symbol    | Access | Value            | Description   |
|-------|-----|-----------|--------|------------------|---|
| 023h  | 7:5 | reserved  | R      | -                | always write 000; ignore on read  |
|       | 4:0 | ID28:ID24 | R/W    | 00h <sup>#</sup> | bits ID28 to ID24 of the extended frame format<br>bits ID10 to ID6 of the standard frame format |

Table 29. Partial networking ID registers 0 to 3 (addresses 020h to 023h)...continued

#### Table 30. Partial networking ID mask registers 0 to 3 (addresses 024h to 027h)

| Addr. | Bit | Symbol   | Access | Value            | Description  |
|-------|-----|----------|--------|------------------|--|
| 024h  | 7:0 | M7:M0    | R/W    | 00h <sup>#</sup> | ID mask bits 7 to 0 of extended frame format   |
| 025h  | 7:0 | M15:M8   | R/W    | 00h <sup>#</sup> | ID mask bits 15 to 8 of extended frame format  |
| 026h  | 7:2 | M23:M18  | R/W    | 00h <sup>#</sup> | ID mask bits 23 to 18 of extended frame format<br>ID mask bits 5 to 0 of standard frame format   |
|       | 1:0 | M17:M16  | R/W    | 00h <sup>#</sup> | ID mask bits 17 to 16 of extended frame format   |
| 027h  | 7:5 | reserved | R/W    | 00h <sup>#</sup> | always write 000; ignore on read   |
|       | 4:0 | M28:M24  | R/W    | 00h <sup>#</sup> | ID mask bits 28 to 24 of extended frame format<br>ID mask. bits 10 to 6 of standard frame format |

#### Table 31. Partial networking data mask registers 0 to 7 (addresses 028h to 02Fh)

| Addr. | Bit | Symbol | Access | Value            | Description               |
|-------|-----|--------|--------|------------------|---------------------------|
| 028h  | 7:0 | DM0    | R/W    | FFh <sup>#</sup> | data mask 0 configuration |
| 029h  | 7:0 | DM1    | R/W    | FFh <sup>#</sup> | data mask 1 configuration |
| 02Ah  | 7:0 | DM2    | R/W    | FFh <sup>#</sup> | data mask 2 configuration |
| 02Bh  | 7:0 | DM3    | R/W    | FFh <sup>#</sup> | data mask 3 configuration |
| 02Ch  | 7:0 | DM4    | R/W    | FFh <sup>#</sup> | data mask 4 configuration |
| 02Dh  | 7:0 | DM5    | R/W    | FFh <sup>#</sup> | data mask 5 configuration |
| 02Eh  | 7:0 | DM6    | R/W    | FFh <sup>#</sup> | data mask 6 configuration |
| 02Fh  | 7:0 | DM7    | R/W    | FFh <sup>#</sup> | data mask 7 configuration |

| Bit     | Symbol   | Access | Value          | Description  |
|---------|----------|--------|----------------|--|
| 7       | IDE      | R/W    |                | identifier format:   |
|         |          |        | 0#             | standard frame format (11-bit)   |
|         |          |        | 1              | extended frame format (29-bit)   |
| 6       | PNDM     | R/W    |                | partial networking data mask:  |
|         |          |        | 0              | data length code and data field are 'don't care' for wake-up               |
|         |          |        | 1 <sup>#</sup> | data length code and data field are evaluated at wake-up                   |
| 5:4     | reserved | R      | -              | always write 00; ignore on read  |
| 3:0     | DLC      | R/W    |                | number of data bytes expected in a CAN frame (DLC):                        |
| TJA1445 |          |        |                | All information provided in this document is subject to legal disclaimers. |

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| Bit | Symbol | Access | Value           | Description |
|-----|--------|--------|-----------------|-------------|
|     |        |        | 0000#           | 0           |
|     |        |        | 0001            | 1           |
|     |        |        | 0010            | 2           |
|     |        |        | 0011            | 3           |
|     |        |        | 0100            | 4           |
|     |        |        | 0101            | 5           |
|     |        |        | 0110            | 6           |
|     |        |        | 0111            | 7           |
|     |        |        | 1000            | 8           |
|     |        |        | 1001 to<br>1111 | 8           |

## Table 32. Partial networking frame control register (address 030h)...continued

#### Table 33. Partial networking data rate and filter configuration register (address 031h)

| Bit | Symbol   | Access | Value            | Description   |
|-----|----------|--------|------------------|---|
| 7:4 | IDFS     | R/W    |                  | idle detection filter select:   |
|     |          |        | 0000#            | bitfilter 0: ignore < 5.0 % of arbitration bit time; detect > 17.5 % of arbitration bit time (500 kbit/s max)     |
|     |          |        | 0001             | ISO bitfilter 1: ignore < 5.0 % of arbitration bit time; detect > 17.5 % of arbitration bit time (500 kbit/s max) |
|     |          |        | 0010             | ISO bitfilter 2: ignore < 2.5 % of arbitration bit time; detect > 8.75 % of arbitration bit time (500 kbit/s max) |
|     |          |        | 0011             | bitfilter 3: ignore < 18 ns; detect > 93 ns   |
|     |          |        | 0100             | bitfilter 4: ignore < 42 ns; detect > 119 ns  |
|     |          |        | 0101             | bitfilter 5: ignore < 67 ns; detect > 145 ns  |
|     |          |        | 0110             | bitfilter 6: ignore < 91 ns; detect > 170 ns  |
|     |          |        | 0111 to<br>1111  | reserved  |
| 3   | reserved | R      | -                | always write 0; ignore on read  |
| 2:0 | CDR      | R/W    |                  | CAN arbitration bit rate selection:   |
|     |          |        | 000              | 50 kbit/s   |
|     |          |        | 001              | 100 kbit/s  |
|     |          |        | 010              | 125 kbit/s  |
|     |          |        | 011              | 250 kbit/s  |
|     |          |        | 100 <sup>#</sup> | 500 kbit/s  |
|     |          |        | 101              | 667 kbit/s  |
|     |          |        | 110              | reserved (PNCORE disabled)  |
|     |          |        | 111              | 1 Mbit/s  |

| Bit                                      | Symbol   | Access                                       | Value | Description   |  |
|--|----------|--|-------|---|--|
| 7:3                                      | reserved | R  | -     | always write 00000; ignore on read  |  |
| 2  | PNECC    | PNECC R/W partial networking error counter c |       | partial networking error counter control:   |  |
|  |          |  | 0#    | CAN FD frames will increment error counter  |  |
|  |          |  | 1     | CAN FD frames will not increment error counter  |  |
| 1 PNCOK                                  |          | R/W  |       | CAN partial networking configuration:   |  |
|  |          |  | 0#    | partial networking register configuration invalid (wake-up via standard wake-up pattern only) |  |
|  |          |  | 1     | partial networking register configuration valid   |  |
| 0 CPNC R/W CAN selective wake-up enable: |          | CAN selective wake-up enable:                |       |   |  |
|  |          |  | 0#    | disable CAN selective wake-up   |  |
|  |          |  | 1     | enable CAN selective wake-up  |  |

### Table 34. Partial networking and CAN configuration register (address 032h)

### 7.10.8 System reset register

### Table 35. System reset register (address FE0h)

| Bit | Symbol | Access | Value | Description                   |
|-----|--------|--------|-------|-------------------------------|
| 7:0 | SFR    | W      |       | software-forced system reset: |
|     |        |        | 01h   | set up system reset           |
|     |        |        | 80h   | confirm system reset          |

### 7.10.9 Wake-up pulse configuration register

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '\*'.

| Bit | Symbol   | Access | Value | Description  |  |
|-----|----------|--------|-------|--|--|
| 7:1 | reserved | R      | -     | always write 00h; ignore on read                     |  |
| 0   | WFC      | R/W    |       | wake-up pulse width (t <sub>wake</sub> ) on WAKE pin |  |
|     |          |        | 0*    | short wake-up time                                   |  |
|     |          |        | 1     | long wake-up time                                    |  |

Table 36. Wake-up pulse configuration register (address 040h)

### 7.10.10 Interrupt registers

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '\*'.

Write 1 to clear (W1C) interrupt status bit after interrupt detected.

| Bit | Symbol   | Access | Value            | Description   |
|-----|----------|--------|------------------|---|
| 7   | reserved | R      | -                | always write 0; ignore on read                      |
| 6   | CWE R/W  |        |                  | CAN wake-up interrupt enable:                       |
|     |          |        | 0*               | disable CAN wake-up interrupt                       |
|     |          |        | 1 <sup>[1]</sup> | enable CAN wake-up interrupt                        |
| 5   | OTE      | R/W    |                  | overtemperature shutdown interrupt enable:          |
|     |          |        | 0*               | disable overtemperature shutdown interrupt          |
|     |          |        | 1                | enable overtemperature shutdown interrupt           |
| 4   | SPIFE    | R/W    |                  | SPI failure interrupt enable:                       |
|     |          |        | 0*               | disable SPI failure interrupt                       |
|     | 1        |        | 1                | enable SPI failure interrupt                        |
| 3   | UVCCE    | R/W    |                  | V <sub>CC</sub> undervoltage interrupt enable:      |
|     |          |        | 0                | disable V <sub>CC</sub> undervoltage interrupt      |
|     |          |        | 1*               | enable V <sub>CC</sub> undervoltage interrupt       |
| 2   | LUVIOE   | R/W    |                  | long V <sub>IO</sub> undervoltage interrupt enable: |
|     |          |        | 0                | disable long V <sub>IO</sub> undervoltage interrupt |
|     |          |        | 1*               | enable long V <sub>IO</sub> undervoltage interrupt  |
| 1   | WPRE     | R/W    |                  | WAKE pin rising-edge interrupt enable:              |
|     |          |        | 0*               | disable WAKE pin rising-edge interrupt              |
|     |          |        | 1 <sup>[1]</sup> | enable WAKE pin rising-edge interrupt               |
| 0   | WPFE     | R/W    |                  | WAKE pin falling-edge interrupt enable:             |
|     |          |        | 0*               | disable WAKE pin falling-edge interrupt             |
|     |          |        | 1 <sup>[1]</sup> | enable WAKE pin falling-edge interrupt              |

Table 37. System interrupt enable register (address 010h)

[1] Value when Sleep mode is entered due to expiration of VIO\_UV\_LONG or MCU\_REAC\_EXP.

### Table 38. CAN interrupt enable register (address 011h)

| Bit | Symbol   | Access | Value | Description                       |  |  |
|-----|----------|--------|-------|-----------------------------------|--|--|
| 7:4 | reserved | R      | -     | always write 0000; ignore on read |  |  |
| 3   | CBSE     | R/W    |       | CAN bus silence interrupt enable: |  |  |
|     |          |        | 0*    | disable CAN bus silence interrupt |  |  |
|     |          |        | 1     | enable CAN bus silence interrupt  |  |  |

| Bit | Symbol                       | Access | Value | Description                             |
|-----|------------------------------|--------|-------|---|
| 2   | BUSDOME                      | R/W    |       | CAN bus dominant interrupt enable:      |
|     |                              |        | 0*    | disable CAN bus dominant interrupt      |
|     |                              |        | 1     | enable CAN bus dominant interrupt       |
| 1   | reserved:<br><i>TJA1445A</i> | R      | -     | always write 0; ignore on read          |
| 1   | TXD2DOME                     | R/W    |       | TXD2 dominant timeout interrupt enable: |
|     | TJA1445B                     |        | 0*    | disable TXD2 dominant timeout interrupt |
|     |                              |        | 1     | enable TXD2 dominant timeout interrupt  |
| 0   | TXDDOME                      | ME R/W |       | TXD dominant timeout interrupt enable:  |
|     |                              |        | 0*    | disable TXD dominant timeout interrupt  |
|     |                              |        | 1     | enable TXD dominant timeout interrupt   |

 Table 38. CAN interrupt enable register (address 011h)...continued

Table 39. GPIO interrupt enable register (address 012h) - TJA1445B only

 For GPIOx wake-up detection, bits GPIOxFS must be set to 0x13, 0x14 or 0x15 (see <u>Table 24</u> to <u>Table 26</u>).

| Bit | Symbol   | Access | Value | Description                        |  |
|-----|----------|--------|-------|------------------------------------|--|
| 7:3 | reserved | R      | -     | always write 00000; ignore on read |  |
| 2   | GPIO3E   | R/W    |       | GPIO3 interrupt enable:            |  |
|     |          |        | 0*    | disable GPIO3 interrupt            |  |
|     |          |        | 1     | enable GPIO3 interrupt             |  |
| 1   | GPIO2E   | 2E R/W |       | GPIO2 interrupt enable:            |  |
|     |          |        | 0*    | disable GPIO2 interrupt            |  |
|     |          |        | 1     | enable GPIO2 interrupt             |  |
| 0   | GPIO1E   | R/W    |       | GPIO1 interrupt enable:            |  |
|     |          |        | 0*    | disable GPIO1 interrupt            |  |
|     |          |        | 1     | enable GPIO1 interrupt             |  |

#### Table 40. System interrupt status register (address 060h)

| Bit | Symbol                    | Access | Value | Description                                   |  |
|-----|---------------------------|--------|-------|---|--|
| 7   | PO <sup>[1]</sup>         | R/W1C  |       | power-on/system reset interrupt:              |  |
|     |                           |        | 0     | no power-on/system reset interrupt detected   |  |
|     |                           |        | 1*    | power-on/system reset interrupt detected      |  |
| 6   | 6 CW <sup>[2]</sup> R/W1C |        |       | CAN wake-up interrupt:                        |  |
|     |                           |        | 0*    | no CAN wake-up interrupt detected             |  |
|     |                           |        | 1     | CAN wake-up interrupt detected                |  |
| 5   | ОТ                        | R/W1C  |       | overtemperature warning interrupt:            |  |
|     |                           |        | 0*    | no overtemperature warning interrupt detected |  |

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| Bit | Symbol             | Access | Value | Description   |
|-----|--------------------|--------|-------|---|
|     |                    |        | 1     | overtemperature warning interrupt detected              |
| 4   | SPIF               | R/W1C  |       | SPI failure interrupt:                                  |
|     |                    |        | 0*    | no SPI failure interrupt detected                       |
|     |                    |        | 1     | SPI failure interrupt detected                          |
| 3   | UVCC               | R/W1C  |       | V <sub>CC</sub> undervoltage interrupt:                 |
|     |                    |        | 0*    | no V <sub>CC</sub> undervoltage interrupt detected      |
|     |                    |        | 1     | V <sub>CC</sub> undervoltage interrupt detected         |
| 2   | LUVIO              | R/W1C  |       | long V <sub>IO</sub> undervoltage interrupt:            |
|     |                    |        | 0*    | no long V <sub>IO</sub> undervoltage interrupt detected |
|     |                    |        | 1     | long V <sub>IO</sub> undervoltage interrupt detected    |
| 1   |                    |        |       | WAKE pin rising-edge interrupt:                         |
|     |                    |        | 0*    | no WAKE pin rising-edge interrupt detected              |
|     |                    |        | 1     | WAKE pin rising-edge interrupt detected                 |
| 0   | WPF <sup>[2]</sup> | R/W1C  |       | WAKE pin falling-edge interrupt:                        |
|     |                    |        | 0*    | no WAKE pin falling-edge interrupt detected             |
|     |                    |        | 1     | WAKE pin falling-edge interrupt detected                |

#### Table 40. System interrupt status register (address 060h)...continued

PO interrupt is always enabled.
 This interrupt is also a wake-up

This interrupt is also a wake-up source.

| Table 41. | CAN interrupt status | s register | (address 061h) |
|-----------|----------------------|------------|----------------|
|-----------|----------------------|------------|----------------|

| Bit | Symbol                       | Access | Value | Description                                 |
|-----|------------------------------|--------|-------|---|
| 7:4 | reserved                     | R      | -     | always write 1111; ignore on read           |
| 3   | CBS                          | R/W1C  |       | CAN bus silence interrupt:                  |
|     |                              |        | 0*    | no CAN bus silence interrupt detected       |
|     |                              |        | 1     | CAN bus silence interrupt detected          |
| 2   | BUSDOM                       | R/W1C  |       | CAN bus dominant interrupt:                 |
|     |                              |        | 0*    | no CAN bus dominant interrupt detected      |
|     |                              |        | 1     | CAN bus dominant interrupt detected         |
| 1   | reserved:<br><i>TJA1445A</i> | R      | -     | always write 0; ignore on read              |
| 1   | TXD2DOM                      | R/W1C  |       | TXD2 dominant timeout interrupt:            |
|     | TJA1445B                     |        | 0*    | no TXD2 dominant timeout interrupt detected |
|     |                              |        | 1     | TXD2 dominant timeout interrupt detected    |
| 0   | TXDDOM                       | R/W1C  |       | TXD dominant timeout interrupt:             |
|     |                              |        | 0*    | no TXD dominant timeout interrupt detected  |
|     |                              |        | 1     | TXD dominant timeout interrupt detected     |

| Bit | Symbol                | Access | Value | Description  |
|-----|-----------------------|--------|-------|--|
| 7:3 | reserved              | R      | -     | always write 11111; ignore on read                             |
| 2   | PNFDER <sup>[1]</sup> | R/W1C  |       | partial networking frame detection error interrupt:            |
|     |                       |        | 0*    | no partial networking frame detection error interrupt detected |
|     |                       |        | 1     | partial networking frame detection error interrupt detected    |
| 1:0 | reserved              | R      | -     | always write 11; ignore on read                                |

Table 42. Partial networking interrupt status register (address 062h)

[1] PNFDER interrupt is always enabled.

| Bit     | Symbol     | Access | Value            | Description                        |
|---------|------------|--------|------------------|------------------------------------|
| 7:3     | reserved   | R      | -                | always write 11111; ignore on read |
| 2       | GPIO3      | R/W1C  |                  | GPIO3 interrupt:                   |
|         |            |        | 0*               | no GPIO3 interrupt detected        |
|         |            |        | 1                | GPIO3 interrupt detected           |
| 1 GPIO2 | PIO2 R/W1C |        | GPIO2 interrupt: |                                    |
|         |            |        | 0*               | no GPIO2 interrupt detected        |
|         |            |        | 1                | GPIO2 interrupt detected           |
| 0       | GPIO1      | R/W1C  |                  | GPIO1 interrupt:                   |
|         |            |        | 0*               | no GPIO1 interrupt detected        |
|         |            |        | 1                | GPIO1 interrupt detected           |

#### Table 43. GPIO interrupt status register (address 063h) - TJA1445B only>

### 7.10.11 Lock control register

Reset values after system startup (BOOT\_OK; see Figure 4) are indicated by '\*'.

| Bit     | Symbol   | Access | Value | Description   |
|---------|----------|--------|-------|---|
| 7:5     | reserved | R      | -     | always write 000; ignore on read  |
| 4       | LKGPM    | R/W    |       | Lock control: general-purpose memory registers (0xFF0 to 0xFF3):  |
|         |          |        | 0*    | SPI write access enabled  |
|         |          |        | 1     | SPI write access disabled   |
| 3       | LKRST    | R/W    |       | Lock control: system reset register (0xFE0):  |
|         |          |        | 0     | SPI write access enabled  |
|         |          |        | 1*    | SPI write access disabled   |
| 2       | LKCFG    | R/W    |       | Lock control: System/Wake/CAN configuration registers (0x40 to 0x46):   |
|         |          |        | 0*    | SPI write access enabled  |
|         |          |        | 1     | SPI write access disabled   |
| 1       | LKPNC    | R/W    |       | Lock control: partial networking configuration registers (0x020 to 0x032):  |
|         |          |        | 0*    | SPI write access enabled  |
| TJA1445 | T        | I      | A     | ر المحمد المحم<br>المحمد المحمد ال<br>المحمد المحمد ال |

Table 44. Lock control register (address 050h)

| Bit | Symbol | Access | Value | Description   |
|-----|--------|--------|-------|---|
|     |        |        | 1     | SPI write access disabled   |
| 0   | LKIE   | R/W    |       | Lock control: interrupt enable registers (0x010, 0x011, 0x012 - TJA1445B only): |
|     |        |        | 0*    | SPI write access enabled  |
|     |        |        | 1     | SPI write access disabled   |

#### Table 44. Lock control register (address 050h)...continued

### 7.10.12 General-purpose memory registers

The TJA1445 allocates 4 bytes of memory for general-purpose registers used to store user information. Note that these registers are not cleared during an SPI system reset. They are cleared when the device enters Off mode.

Table 45. General-purpose memory registers 0 to 3 (addresses FF0h to FF3h)

| Addr. | Bit | Symbol     | Access | Value | Description              |
|-------|-----|------------|--------|-------|--------------------------|
| FF0h  | 7:0 | GPM[7:0]   | R/W    | 00h   | general-purpose memory 0 |
| FF1h  | 7:0 | GPM[15:8]  | R/W    | 00h   | general-purpose memory 1 |
| FF2h  | 7:0 | GPM[23:16] | R/W    | 00h   | general-purpose memory 2 |
| FF3h  | 7:0 | GPM[31:24] | R/W    | 00h   | general-purpose memory 3 |

### 7.10.13 Device identification register

| Table 46. | Device | identification | register | (address | FFFh) |
|-----------|--------|----------------|----------|----------|-------|
|-----------|--------|----------------|----------|----------|-------|

| Bit | Symbol | Access | Value | Description                   |
|-----|--------|--------|-------|-------------------------------|
| 7:0 | IDS    | R      |       | device identification number: |
|     |        |        | 01h   | TJA1445A                      |
|     |        |        | 02h   | TJA1445B                      |

### 8 Limiting values

#### Table 47. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134); all voltages are referenced to pin GND, unless otherwise specified; positive currents flow into the IC.

| Symbol                   | Parameter                                | Conditions   |      | Min  | Max                                  | Unit |
|--------------------------|--|--|------|------|--------------------------------------|------|
| V <sub>x</sub>           | Voltage on pin x <sup>[1]</sup>          | pins VCC, VIO  |      | -0.3 | +6                                   | V    |
|                          |  |  |      | -    | +7 <sup>[2]</sup>                    | V    |
|                          |  | pin VBAT   |      | -    | +40                                  | V    |
|                          |  | pin INH  |      | -0.3 | V <sub>BAT</sub> +0.3 <sup>[3]</sup> | V    |
|                          |  | pins CANH, CANL, WAKE  |      | -36  | +40                                  | V    |
|                          |  | pins RXD, TXD, SCSN, SCK, SDI, SDO,<br>TXEN_N, GPIOx   |      | -0.3 | V <sub>IO</sub> +0.3 <sup>[4]</sup>  | V    |
| I <sub>r(VBAT)</sub>     | reverse current on pin<br>VBAT           |  |      | -10  | -                                    | mA   |
| I <sub>O(INH)</sub>      | output current on pin INH                |  |      | -2   | -                                    | mA   |
| I <sub>O(TXEN_N)</sub>   | output current on pin<br>TXEN_N          |  |      | -    | 18                                   | mA   |
| V <sub>(CANH-CANL)</sub> | voltage between pin CANH<br>and pin CANL |  |      | -40  | +40                                  | V    |
| V <sub>trt</sub>         | transient voltage                        | on pin VBAT; on pins CANH, CANL and WAKE via 1 nF capacitor; pin WAKE with 3 k $\Omega$ resistor | [5]  |      |                                      |      |
|                          |  | pulse 1  |      | -100 | -                                    | V    |
|                          |  | pulse 2a   |      | -    | +75                                  | V    |
|                          |  | pulse 3a   |      | -150 | -                                    | V    |
|                          |  | pulse 3b   |      | -    | +100                                 | V    |
| V <sub>ESD</sub>         | electrostatic discharge                  | IEC 61000-4-2 (150 pF, 330 $\Omega$ discharge circuit)   | [6]  |      |                                      |      |
|                          | voltage                                  | on pins CANH, CANL; on pin VBAT via<br>100 nF capacitor; on pin WAKE with ≥3 kΩ<br>resistor      |      | -8   | +8                                   | kV   |
|                          |  | Human Body Model (HBM)   |      |      |                                      |      |
|                          |  | on any pin   | [7]  | -4   | +4                                   | kV   |
|                          |  | on pins CANH, CANL   | [8]  | -8   | +8                                   | kV   |
|                          |  | Charged Device Model (CDM)   | [9]  |      |                                      |      |
|                          |  | on any pin   |      | -500 | +500                                 | V    |
|                          |  | on corner pins   | [10] | -750 | +750                                 | V    |
| T <sub>vj</sub>          | virtual junction temperature             |  | [11] | -40  | +150                                 | °C   |
| T <sub>stg</sub>         | storage temperature                      |  | [12] | -55  | +150                                 | °C   |

[1] The device can sustain voltages up to the specified values over the product lifetime, provided applied voltages (including transients) never exceed these values.

 $\label{eq:constraint} [2] \qquad \mbox{The device can withstand voltages between 6 V and 7 V for a total of 20 s over the product lifetime.}$ 

[3] Absolute maximum of 40 V.

[4] Subject to the qualifications detailed in Table notes 1 and 2 above for pin VIO, and for VIO-related pins.

[5] Verified by an external test house according to IEC TS 62228, Section 4.2.4; parameters for standard pulses defined in ISO 7637, part 2.

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[6] Verified by an external test house according to IEC TS 62228, Section 4.3.

[7] According to AEC-Q100-002.

[8] Pins stressed to reference group containing all ground and supply pins, emulating the application circuits (Figure 14 and Figure 15). HBM pulse as specified in AEC-Q100-002 used.

[9] According to AEC-Q100-011.

[10] Only valid for TJA1445AT.

[11] In accordance with IEC 60747-1. An alternative definition of virtual junction temperature is:  $T_{vj} = T_{amb} + P \times R_{th(j-a)}$ , where  $R_{th(j-a)}$  is a fixed value used in the calculation of  $T_{vj}$ . The rating for  $T_{vj}$  limits the allowable combinations of power dissipation (P) and ambient temperature ( $T_{amb}$ ).

[12]  $T_{sta}$  in application according to IEC61360-4. For component transport and storage conditions, see instead IEC61760-2.

### 9 Thermal characteristics

#### Table 48. Thermal characteristics

Value determined for free convection conditions on a JEDEC 2S2P board.

| Symbol               | Parameter  | Conditions <sup>[1]</sup> | Тур                                   | Unit |
|----------------------|--|---------------------------|---------------------------------------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient                        | SO14                      | 85                                    | K/W  |
|                      |  | HVSON14                   | 85<br>71<br>69<br>34<br>29<br>8<br>11 | K/W  |
|                      |  | DHVQFN18                  | 69                                    | K/W  |
| R <sub>th(j-c)</sub> | thermal resistance from junction to case <sup>[2]</sup>            | HVSON14                   | /SON14 34 H<br>HVQFN18 29 H           | K/W  |
|                      |  | DHVQFN18                  |                                       | K/W  |
| $\Psi_{j-top}$       | thermal characterization parameter from junction to top of package | SO14                      | 8                                     | K/W  |
|                      |  | HVSON14                   | 11                                    | K/W  |
|                      |  | DHVQFN18                  | 9                                     | K/W  |

[1] According to JEDEC JESD51-2, JESD51-5 and JESD51-7 at natural convection on 2s2p board. Board with two inner copper layers (thickness: 35 µm) and thermal via array under the exposed pad connected to the first inner copper layer (thickness: 70 µm).

[2] Case temperature refers to the center of the heatsink at the bottom of the package.

### **10** Static characteristics

#### Table 49. Static characteristics

 $T_{vj}$  = -40 °C to +150°C;  $V_{CC}$  = 4.5 V to 5.5 V;  $V_{IO}$  = 1.71 V to 5.5 V;  $V_{BAT}$  = 4.75 V to 40 V;  $R_{L}$  = 60  $\Omega$  unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC.<sup>[7]</sup>

| Symbol             | Parameter                       | Conditions  | Min  | Тур | Мах  | Unit |
|--------------------|---------------------------------|---|------|-----|------|------|
| Supply; pi         | n VCC                           | ·   |      |     |      |      |
| V <sub>CC</sub>    | supply voltage                  |   | 4.5  | -   | 5.5  | V    |
| V <sub>uvd</sub>   | undervoltage detection voltage  | [2  | ] 4  | -   | 4.5  | V    |
| V <sub>uvhys</sub> | undervoltage hysteresis voltage |   | 50   | -   | -    | mV   |
| I <sub>CC</sub>    | supply current                  | Normal mode; transmitter dominant   | -    | 38  | 60   | mA   |
|                    |                                 | Normal mode; short circuit on bus lines;<br>-3 V < (V <sub>CANH</sub> = V <sub>CANL</sub> ) < +40 V         | -    | -   | 125  | mA   |
|                    |                                 | Normal mode, transmitter recessive  | -    | 6   | 9    | mA   |
|                    |                                 | ListenOnly mode, LPL = 0  | -    | 6   | 9    | mA   |
|                    |                                 | ListenOnly mode; LPL = 1; VBATVCC = 0;<br>$T_{vj}$ < 150 °C   | -    | -   | 30   | μA   |
|                    |                                 | ListenOnly mode; LPL = 1; VBATVCC = 1;<br>$T_{vj}$ < 150 °C   | -    | 90  | 165  | μA   |
|                    |                                 | Standby or Sleep mode; T <sub>vj</sub> < 85 °C  | -    | -   | 3    | μA   |
|                    |                                 | Standby or Sleep mode; $T_{vj}$ < 150 °C  | -    | -   | 30   | μA   |
| I/O level a        | dapter supply; pin VIO          |   |      |     |      |      |
| V <sub>IO</sub>    | supply voltage                  |   | 1.71 | -   | 5.5  | V    |
| V <sub>uvd</sub>   | undervoltage detection voltage  | [2  | 1.5  | -   | 1.71 | V    |
| V <sub>uvhys</sub> | undervoltage hysteresis voltage |   | 33   | -   | -    | mV   |
| I <sub>IO</sub>    | supply current                  | Normal or ListenOnly mode (excluding pull-<br>up currents on $V_{IO}$ -related pins);<br>$V_{TXD} = V_{IO}$ | -    | -   | 5    | μA   |
|                    |                                 | Standby or Sleep mode; T <sub>vj</sub> < 85 °C  | -    | -   | 2    | μA   |
|                    |                                 | Standby or Sleep mode; T <sub>vj</sub> < 150 °C   | -    | -   | 4    | μA   |
| Supply; pi         | n VBAT                          |   |      |     |      |      |
| V <sub>BAT</sub>   | battery supply voltage          |   | 4.75 | -   | 40   | V    |
| V <sub>uvd</sub>   | undervoltage detection voltage  | all modes <sup>[2</sup>   | 4.25 | -   | 4.75 | V    |
| I <sub>BAT</sub>   | battery supply current          | Normal mode or (ListenOnly mode; VBATVCC = 1 or LPL = 0); pin INH left open; $V_{BAT} \le 28 \text{ V}$     |      | -   | 400  | μA   |
|                    |                                 | ListenOnly mode; VBATVCC = 0 and [3 LPL = 1; pin INH left open; $V_{BAT} \le 28 \text{ V}$                  | ] -  | -   | 525  | μA   |

### Table 49. Static characteristics...continued

 $T_{vj}$  = -40 °C to +150°C;  $V_{CC}$  = 4.5 V to 5.5 V;  $V_{IO}$  = 1.71 V to 5.5 V;  $V_{BAT}$  = 4.75 V to 40 V;  $R_{I}$  = 60  $\Omega$  unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC.<sup>[7]</sup>

| Symbol                | Parameter                        | Conditions  | Min                | Тур  | Мах                | Unit |
|-----------------------|----------------------------------|---|--------------------|------|--------------------|------|
|                       |                                  | Sleep or Standby mode; CAN Offline<br>Bias mode; pin INH left open; CWE = 1;<br>CPNC = 1; PNCOK = 1; $V_{WAKE} = V_{BAT}$ ;<br>$V_{BAT} \le 28 \text{ V}$ | ]                  |      |                    |      |
|                       |                                  | VBATVCC = 0; T <sub>vj</sub> < 85 °C  | -                  | -    | 450                | μA   |
|                       |                                  | VBATVCC = 0; T <sub>vj</sub> < 150 °C   | -                  | -    | 500                | μA   |
|                       |                                  | VBATVCC = 1; T <sub>vj</sub> < 85 °C  | -                  | -    | 350                | μA   |
|                       |                                  | VBATVCC = 1; T <sub>vj</sub> < 150 °C   | -                  | -    | 375                | μA   |
|                       |                                  | Sleep or Standby mode; CAN Offline<br>mode; pin INH left open; $V_{WAKE} = V_{BAT}$ or<br>GND; $V_{BAT} \le 28 \text{ V}$                                 |                    |      |                    |      |
|                       |                                  | T <sub>vj</sub> < 85 °C   | -                  | 12   | 20                 | μA   |
|                       |                                  | T <sub>vj</sub> < 150 °C  | -                  | 12   | 32                 | μA   |
|                       |                                  | $V_{BAT}$ = 32 V; BCCTRL = 0; additional<br>current due to $V_{BAT}$ being increased to<br>32 V   |                    | 0.15 | 0.5                | mA   |
|                       |                                  | $V_{BAT}$ = 40 V; BCCTRL = 0; additional<br>current due to $V_{BAT}$ being increased to<br>40 V   |                    | 1.2  | 1.8                | mA   |
| CAN trans             | mit data input; pin TXD          |   | 1                  |      | 1                  |      |
| V <sub>IH</sub>       | HIGH-level input voltage         |   | 0.7V <sub>IO</sub> | -    | -                  | V    |
| V <sub>IL</sub>       | LOW-level input voltage          |   | -                  | -    | 0.3V <sub>IO</sub> | V    |
| V <sub>hys(TXD)</sub> | hysteresis voltage on pin<br>TXD |   | 50                 | -    | -                  | mV   |
| R <sub>pu</sub>       | pull-up resistance               |   | 20                 | -    | 80                 | kΩ   |
| I <sub>IL(off)</sub>  | off state input leakage current  | Off or Boot mode or $V_{IO} < V_{uvd(VIO)}$ ;<br>0 V < $V_{TXD} < V_{IO}$   | -5                 | -    | +5                 | μA   |
| C <sub>i</sub>        | input capacitance                | [3  | ] _                | -    | 10                 | pF   |
| CAN receiv            | ve data output; pin RXD          |   |                    |      |                    |      |
| I <sub>OH</sub>       | HIGH-level output current        | $V_{RXD} = V_{IO} - 0.4 V$  | -10                | -    | -1                 | mA   |
| I <sub>OL</sub>       | LOW-level output current         | V <sub>RXD</sub> = 0.4 V  | 1                  | -    | 10                 | mA   |
| I <sub>IL(off)</sub>  | off state input leakage current  | Off or Boot mode or $V_{IO} < V_{uvd(VIO)}$ ;<br>0 V < $V_{RXD} < V_{IO}$   | -5                 | -    | +5                 | μA   |
| Inhibit outp          | out pin; pin INH                 |   |                    |      |                    |      |
| ΔV <sub>H</sub>       | HIGH-level voltage drop          | $\Delta V_{H} = V_{BAT} - V_{INH}; I_{INH} = -1 \text{ mA}$   | 0                  | -    | 1                  | V    |
|                       |                                  | $\Delta V_{H} = V_{BAT} - V_{INH}; I_{INH} = -2 \text{ mA}$   | 0                  | -    | 2                  | V    |
| IL                    | leakage current                  | Sleep mode; Off mode  | -2                 | -    | +2                 | μA   |
| I <sub>O(sc)</sub>    | short-circuit output current     | V <sub>INH</sub> = 0 V  | -15                | -    | -                  | mA   |
| Serial peri           | oheral interface                 |   |                    |      |                    |      |

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#### Table 49. Static characteristics...continued

 $T_{vj}$  = -40 °C to +150°C;  $V_{CC}$  = 4.5 V to 5.5 V;  $V_{IO}$  = 1.71 V to 5.5 V;  $V_{BAT}$  = 4.75 V to 40 V;  $R_{I}$  = 60  $\Omega$  unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC.<sup>[7]</sup>

| Symbol               | Parameter                        | Conditions  | Min                | Тур | Мах                | Unit |
|----------------------|----------------------------------|---|--------------------|-----|--------------------|------|
| input pins           | SDI, SCK and SCSN                |   |                    |     | L                  |      |
| V <sub>IH</sub>      | HIGH-level input voltage         |   | 0.7V <sub>IO</sub> | -   | -                  | V    |
| V <sub>IL</sub>      | LOW-level input voltage          |   | -                  | -   | 0.3V <sub>IO</sub> | V    |
| V <sub>hys</sub>     | hysteresis voltage               |   | 50                 | -   | -                  | mV   |
| R <sub>pd</sub>      | pull-down resistance             | on pins SCK and SDI; $V_{SCK} = V_{IL}$ ; $V_{SDI} = V_{IL}$  | 20                 | -   | 80                 | kΩ   |
| R <sub>pu</sub>      | pull-up resistance               | on pins SCK and SDI; $V_{SCK} = V_{IH}$ ; $V_{SDI} = V_{IH}$  | 20                 | -   | 80                 | kΩ   |
|                      |                                  | on pin SCSN   | 20                 | -   | 80                 | kΩ   |
| I <sub>IL(off)</sub> | off state input leakage current  | pins SDI and SCK; Off or Boot mode or $V_{IO} < V_{uvd(VIO)}$ ; 0 V < $V_{SDI} < V_{IO}$ ; 0 V < $V_{SCK} < V_{IO}$ | -5                 | -   | +5                 | μA   |
| Ci                   | input capacitance                | [3  | -                  | -   | 10                 | pF   |
| output pin           | SDO                              |   |                    |     |                    |      |
| I <sub>OH</sub>      | HIGH-level output current        | $V_{SDO} = VIO - 0.4 V$   | -10                | -   | -1                 | mA   |
| I <sub>OL</sub>      | LOW-level output current         | $V_{SDO} = 0.4 V$   | 1                  | -   | 10                 | mA   |
| I <sub>OL(off)</sub> | Off state output leakage current | $V_{SCSN} = V_{IO}$ or Off or Boot mode or<br>$V_{IO} < V_{uvd(VIO)}$ ; 0 V < $V_{SDO} < V_{IO}$                    | -5                 | -   | +5                 | μA   |
| General p            | urpose I/Os; pins GPIOx (TJA1    | 445B only)  |                    |     |                    |      |
| I <sub>OH</sub>      | HIGH-level output current        | V <sub>GPIOx</sub> = VIO - 0.4 V; depending on GPIO configuration   | -10                | -   | -1                 | mA   |
| I <sub>OL</sub>      | LOW-level output current         | V <sub>GPIOx</sub> = 0.4 V; depending on GPIO configuration   | 1                  | -   | 10                 | mA   |
| V <sub>IH</sub>      | HIGH-level input voltage         | depending on GPIO configuration   | 0.7V <sub>IO</sub> | -   | -                  | V    |
| V <sub>IL</sub>      | LOW-level input voltage          | depending on GPIO configuration   | -                  | -   | 0.3V <sub>IO</sub> | V    |
| V <sub>hys</sub>     | hysteresis voltage               | depending on GPIO configuration   | 50                 | -   | -                  | mV   |
| R <sub>pu</sub>      | pull-up resistance               | depending on GPIO configuration   | 20                 | -   | 80                 | kΩ   |
| R <sub>pd</sub>      | pull-down resistance             | depending on GPIO configuration   | 20                 | -   | 80                 | kΩ   |
| I <sub>OL(off)</sub> | Off state output leakage current | high-Z or $V_{IO} < V_{uvd(VIO)}$ ; 0 V < $V_{GPIOX} < V_{IO}$  | -5                 | -   | 5                  | μA   |
| C <sub>i</sub>       | input capacitance                | [3  | -                  | -   | 10                 | pF   |
| Transmitte           | er enable/disable input; pin TXE | EN_N (TJA1445B only)  |                    | •   |                    | ·    |
| V <sub>IH</sub>      | HIGH-level input voltage         |   | 0.7V <sub>IO</sub> | -   | -                  | V    |
| V <sub>IL</sub>      | LOW-level input voltage          |   | -                  | -   | 0.3V <sub>IO</sub> | V    |
| V <sub>hys</sub>     | hysteresis voltage               |   | 50                 | -   | -                  | mV   |
| R <sub>pu</sub>      | pull-up resistance               |   | 20                 | -   | 80                 | kΩ   |
| Ci                   | input capacitance                | [3  | l _                | -   | 10                 | pF   |

#### Table 49. Static characteristics...continued

 $T_{vj}$  = -40 °C to +150°C;  $V_{CC}$  = 4.5 V to 5.5 V;  $V_{IO}$  = 1.71 V to 5.5 V;  $V_{BAT}$  = 4.75 V to 40 V;  $R_{I}$  = 60  $\Omega$  unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC.<sup>[7]</sup>

| Symbol                 | Parameter                                  | Conditions   |                   | Min                | Тур | Max                | Unit |
|------------------------|--|--|-------------------|--------------------|-----|--------------------|------|
| Local wake             | e-up input; pin WAKE                       | ·  |                   |                    |     |                    |      |
| R <sub>pu</sub>        | pull-up resistance                         | $V_{WAKE} > V_{th(wake)(max)}$ for t > t <sub>wake(max)</sub>  |                   | 100                | -   | 400                | kΩ   |
| R <sub>pd</sub>        | pull-down resistance                       | V <sub>WAKE</sub> < V <sub>th(wake)(min)</sub> for t > t <sub>wake(max)</sub>  |                   | 100                | -   | 400                | kΩ   |
| V <sub>th(wake)</sub>  | wake-up threshold voltage                  |  |                   | 1.8                | -   | 2.6                | V    |
| V <sub>hys</sub>       | hysteresis voltage                         |  |                   | 90                 | -   | -                  | mV   |
| Bus lines;             | pins CANH and CANL                         |  |                   | 1                  | 1   | -                  |      |
| V <sub>O(dom)</sub>    | dominant output voltage                    | CAN Active mode; $V_{TXD} = 0 V$ ;<br>t < $t_{to(dom)TXD}$ ; $V_{CC} \ge 4.75 V$   |                   |                    |     |                    |      |
|                        |  | pin CANH; R <sub>L</sub> = 50 Ω to 65 Ω  |                   | 2.75               | 3.5 | 4.5                | V    |
|                        |  | pin CANL; $R_L$ = 50 Ω to 65 Ω   |                   | 0.5                | 1.5 | 2.25               | V    |
| V <sub>TXsym</sub>     | transmitter voltage<br>symmetry            | $V_{TXsym} = V_{CANH} + V_{CANL}; C_{SPLIT} = 4.7 \text{ nF};$<br>f <sub>TXD</sub> = 250 kHz, 1 MHz or 2.5 MHz                                   | [3]<br>[5]        | 0.9V <sub>CC</sub> | -   | 1.1V <sub>CC</sub> | V    |
| V <sub>cm(step)</sub>  | common mode voltage step                   |  | [3]<br>[5]<br>[6] | -150               | -   | +150               | mV   |
| V <sub>cm(p-p)</sub>   | peak-to-peak common mode<br>voltage        |  | [3]<br>[5]<br>[6] | -300               | -   | +300               | mV   |
| V <sub>O(dif)</sub>    | differential output voltage                | CAN Active mode; dominant; Normal mode; $V_{CC} \ge 4.75$ ; $V_{TXD} = 0 V$ ; $t < t_{to(dom)TXD}$   | [5]               |                    |     |                    |      |
|                        |  | $R_L = 50 \Omega$ to 65 $\Omega$   |                   | 1.5                | -   | 3                  | V    |
|                        |  | $R_L$ = 45 Ω to 70 Ω   |                   | 1.4                | -   | 3.3                | V    |
|                        |  | R <sub>L</sub> = 2240 Ω  | [3]               | 1.5                | -   | 5                  | V    |
|                        |  | CAN Active mode, recessive; CAN Listen<br>Only or CAN Offline Bias mode; $V_{TXD}$ =<br>$V_{IO}$ ; no load                                       |                   | -50                | -   | +50                | mV   |
|                        |  | CAN Offline mode; no load  |                   | -0.2               | -   | +0.2               | V    |
| V <sub>O(rec)</sub>    | recessive output voltage                   | CAN Active, CAN ListenOnly or<br>CAN Offline Bias mode; $V_{TXD} = V_{IO}$ ;<br>VBATVCC = 1 or (VBATVCC = 0 and<br>$V_{BAT} \ge 5.5$ V); no load |                   | 2                  | 2.5 | 3                  | V    |
|                        |  | CAN Offline mode; no load  |                   | -0.1               | 0   | +0.1               | V    |
| V <sub>th(RX)dif</sub> | differential receiver<br>threshold voltage | $-12 V \le V_{CANH} \le +12 V;$<br>$-12 V \le V_{CANL} \le +12 V$  |                   |                    |     |                    |      |
|                        |  | CAN Active, CAN ListenOnly or CAN<br>Offline Bias mode   |                   | 0.5                | -   | 0.9                | V    |
|                        |  | CAN Offline mode   |                   | 0.4                | -   | 1.1                | V    |
| V <sub>rec(RX)</sub>   | receiver recessive voltage                 | $-12 V \le V_{CANH} \le +12 V;$<br>-12 V \le V_{CANL} \le +12 V  |                   |                    |     |                    |      |

### Table 49. Static characteristics...continued

 $T_{vj}$  = -40 °C to +150°C;  $V_{CC}$  = 4.5 V to 5.5 V;  $V_{IO}$  = 1.71 V to 5.5 V;  $V_{BAT}$  = 4.75 V to 40 V;  $R_L$  = 60  $\Omega$  unless specified otherwise; all voltages are defined with respect to ground; positive currents flow into the IC.<sup>[7]</sup>

| Symbol                   | Parameter                                   | Conditions  | Min               | Тур | Max  | Unit |
|--------------------------|---|---|-------------------|-----|------|------|
|                          |   | CAN Active, CAN ListenOnly or CAN<br>Offline Bias mode  | -8                | -   | +0.5 | V    |
|                          |   | CAN Offline mode  | -8                | -   | +0.4 | V    |
| V <sub>dom(RX)</sub>     | receiver dominant voltage                   | $-12 \text{ V} \le \text{V}_{CANH} \le +12 \text{ V};$<br>$-12 \text{ V} \le \text{V}_{CANL} \le +12 \text{ V}$   |                   |     |      |      |
|                          |   | CAN Active, CAN ListenOnly or CAN<br>Offline Bias mode  | 0.9               | -   | 9    | V    |
|                          |   | CAN Offline mode  | 1.1               | -   | 9    | V    |
| V <sub>hys(RX)</sub> dif | differential receiver<br>hysteresis voltage | -12 V $\leq$ V <sub>CANH</sub> $\leq$ +12 V;<br>-12 V $\leq$ V <sub>CANL</sub> $\leq$ +12 V; CAN Active, CAN<br>ListenOnly or CAN Offline Bias mode; no<br>load                       | 50                | -   | -    | mV   |
| I <sub>O(sc)</sub>       | short-circuit output current                | $-15 \text{ V} \le \text{V}_{CANH} \le +40 \text{ V};$<br>$-15 \text{ V} \le \text{V}_{CANL} \le +40 \text{ V}$   | -                 | -   | 115  | mA   |
| I <sub>O(sc)</sub> rec   | recessive short-circuit output<br>current   | $\label{eq:Variation} \begin{array}{l} -27 \ V \leq V_{CANH} \leq +32 \ V; \\ -27 \ V \leq V_{CANL} \leq +32 \ V; \\ \text{Normal or ListenOnly mode; } V_{TXD} = V_{IO} \end{array}$ | -3                | -   | +3   | mA   |
| IL                       | leakage current                             | $V_{CC} = V_{IO} = V_{BAT} = 0 V$ or pins shorted to<br>GND via 47 K $\Omega$ ; $V_{CANH} = V_{CANL} = 5 V$ ;   | -10               | -   | +10  | μA   |
| R <sub>i</sub>           | input resistance                            | $-2 \text{ V} \leq \text{V}_{\text{CANL}} \leq +7 \text{ V}; -2 \text{ V} \leq \text{V}_{\text{CANH}} \leq +7 \text{ V}$  | 16                | 32  | 50   | kΩ   |
| ΔR <sub>i</sub>          | input resistance deviation                  | $0 V \le V_{CANL} \le +5 V$ ; $0 V \le V_{CANH} \le +5 V$   | -3                | -   | +3   | %    |
| R <sub>i(dif)</sub>      | differential input resistance               | $-2 \text{ V} \leq \text{V}_{\text{CANL}} \leq +7 \text{ V}; -2 \text{ V} \leq \text{V}_{\text{CANH}} \leq +7 \text{ V}$  | 32                | 64  | 100  | kΩ   |
| C <sub>i</sub>           | input capacitance                           | ]   | 3] -              | -   | 20   | pF   |
| C <sub>i(dif)</sub>      | differential input capacitance              | ]   | 3] -              | -   | 10   | pF   |
| Temperatu                | re detection                                | ·   |                   |     |      |      |
| $T_{j(sd)}$              | shutdown junction<br>temperature            |   | <sup>3]</sup> 180 | -   | 200  | °C   |
| T <sub>j(sd)rel</sub>    | release shutdown junction temperature       |   | <sup>3]</sup> 175 | -   | 195  | °C   |

All parameters are guaranteed over the junction temperature range by design. Factory testing uses correlated test conditions to cover the specified [1]

temperature and power supply voltage ranges. Undervoltage is detected between min and max values. Undervoltage is guaranteed to be detected below min value and guaranteed not to be detected [2] above max value.

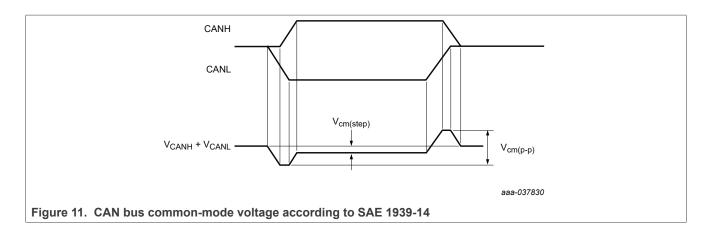
[3]

Not tested in production; guaranteed by design. The pull-up resistance on pin SCSN is a differential resistance. The test circuit used to measure the bus output voltage symmetry and the common-mode voltages (which includes C<sub>SPLIT</sub>) is shown in Figure 17. [4] [5] [6] See Figure 11.

### **NXP Semiconductors**

## **TJA1445**

High-speed CAN transceiver with partial networking



## **11** Dynamic characteristics

#### Table 50. Dynamic characteristics

 $T_{vj}$  = -40 °C to +150 °C;  $V_{CC}$  = 4.5 V to 5.5 V;  $V_{IO}$  = 1.71 V to 5.5 V;  $V_{BAT}$  = 4.75 V to 40 V;  $R_L$  = 60  $\Omega$  unless specified otherwise; all voltages are defined with respect to ground.<sup>[1]</sup>

| Symbol                          | Parameter  | Conditions  |            | Min      | Тур     | Max                      | Unit |
|---------------------------------|--|---|------------|----------|---------|--------------------------|------|
| CAN FD timin                    | g characteristics according to ISO 11898-2:              | 2024; see <u>Figure 12</u> and <u>Figure 16</u>     |            |          |         |                          |      |
| t <sub>d(TXD-busdom)</sub>      | delay time from TXD to bus dominant                      | Normal mode   |            | -        | -       | 102.5                    | ns   |
| t <sub>d(TXD-busrec)</sub>      | delay time from TXD to bus recessive                     | Normal mode   |            | -        | -       | 102.5                    | ns   |
| t <sub>d(busdom-RXD)</sub>      | delay time from bus dominant to RXD                      | Normal or ListenOnly mode                           |            | -        | -       | 131                      | ns   |
| t <sub>d(busrec-RXD)</sub>      | delay time from bus recessive to RXD                     | Normal or ListenOnly mode                           |            | -        | -       | 131                      | ns   |
| t <sub>d(TXDL-RXDL)</sub>       | delay time from TXD LOW to RXD LOW                       | Normal mode   |            | -        | -       | 220                      | ns   |
| t <sub>d(TXDH-RXDH)</sub>       | delay time from TXD HIGH to RXD HIGH                     | Normal mode   |            | -        | -       | 220                      | ns   |
| CAN FD timin<br>Figure 12 and   | g characteristics according to ISO 11898-2:<br>Figure 16 | 2024 parameter set B ( $t_{bit(TXD)} \ge 20$        | 0 n        | s, up to | o 5 Mbi | t/s) <sup>[2]</sup> ; se | e    |
| ∆t <sub>bit(bus)</sub>          | transmitted recessive bit width deviation                | $\Delta t_{bit(bus)} = t_{bit(bus)} - t_{bit(TXD)}$ |            | -45      | -       | +10                      | ns   |
| Δt <sub>rec</sub>               | receiver timing symmetry                                 | $\Delta t_{rec} = t_{bit(RXD)} - t_{bit(bus)}$      |            | -45      | -       | +15                      | ns   |
| Δt <sub>bit(RXD)</sub>          | received recessive bit width deviation                   | $\Delta t_{bit(RXD)} = t_{bit(RXD)} - t_{bit(TXD)}$ |            | -80      | -       | +20                      | ns   |
| Dominant time                   | e-out times  | •   |            |          |         |                          |      |
| t <sub>to(dom)TXD</sub>         | TXD dominant time-out time                               |   | [3]<br>[4] | 0.8      | -       | 4                        | ms   |
| t <sub>to(dom)bus</sub>         | bus dominant time-out time                               |   | [3]<br>[4] | 0.8      | -       | 4                        | ms   |
| Bus wake-up                     | times; pins CANH and CANL; see <u>Figure 6</u>           | and <u>Figure 7</u>                                 |            | <u> </u> | 1       |                          | 1    |
| t <sub>wake(busdom)</sub>       | bus dominant wake-up time                                |   | [3]<br>[5] | 0.5      | -       | 1.45                     | μs   |
| t <sub>wake(busrec)</sub>       | bus recessive wake-up time                               |   | [3]<br>[5] | 0.5      | -       | 1.45                     | μs   |
| t <sub>to(wake)bus</sub>        | bus wake-up time-out time                                |   | [3]<br>[4] | 0.8      | -       | 9                        | ms   |
| t <sub>d(busact-bias)</sub> [6] | bus bias reaction time                                   | CAN Offline mode                                    | [3]        | -        | -       | 250                      | μs   |
| t <sub>to(silence)</sub>        | bus silence time-out time                                |   | [3]<br>[4] | 0.6      | -       | 1.2                      | s    |
| Serial periphe                  | ral interface timing; pins SCSN, SCK, SDI a              | and SDO; see <u>Figure 13<sup>[3]</sup></u>         |            |          | 1       | 1                        | 1    |
| t <sub>cy(clk)</sub>            | clock cycle time   | Normal, ListenOnly, Standby or Sleep mode           |            | 250      | -       | -                        | ns   |
| t <sub>SPILEAD</sub>            | SPI enable lead time                                     | Normal, ListenOnly, Standby or Sleep mode           |            | 50       | -       | -                        | ns   |
| t <sub>SPILAG</sub>             | SPI enable lag time                                      | Normal, ListenOnly, Standby or Sleep mode           |            | 50       | -       | -                        | ns   |
| t <sub>clk(H)</sub>             | clock HIGH time  | Normal, ListenOnly, Standby or Sleep mode           |            | 100      | -       | -                        | ns   |

#### Table 50. Dynamic characteristics...continued

 $T_{vj} = -40 \text{ °C}$  to +150 °C;  $V_{CC} = 4.5 \text{ V}$  to 5.5 V;  $V_{IO} = 1.71 \text{ V}$  to 5.5 V;  $V_{BAT} = 4.75 \text{ V}$  to 40 V;  $R_L = 60 \Omega$  unless specified otherwise; all voltages are defined with respect to ground.<sup>[1]</sup>

| Symbol                                | Parameter                              | Conditions  |            | Min | Тур | Max  | Unit |
|---------------------------------------|--|---|------------|-----|-----|------|------|
| t <sub>clk(L)</sub>                   | clock LOW time                         | Normal, ListenOnly, Standby or Sleep mode   |            | 100 | -   | -    | ns   |
| t <sub>r(clk)</sub>                   | clock rise time                        | Normal, ListenOnly, Standby or<br>Sleep mode; 10 % to 90 %  |            | -   | -   | 20   | ns   |
| t <sub>f(clk)</sub>                   | clock fall time                        | Normal, ListenOnly, Standby or<br>Sleep mode; 90 % to 10 %  |            | -   | -   | 20   | ns   |
| t <sub>su(D)</sub>                    | data input set-up time                 | Normal, ListenOnly, Standby or Sleep mode   |            | 50  | -   | -    | ns   |
| t <sub>h(D)</sub>                     | data input hold time                   | Normal, ListenOnly, Standby or Sleep mode   |            | 50  | -   | -    | ns   |
| t <sub>v(Q)</sub>                     | data output valid time                 | C <sub>L</sub> = 30 pF; Normal, ListenOnly,<br>Standby or Sleep mode; pin<br>SDO                                  |            | -   | -   | 50   | ns   |
| t <sub>d(SDI-SDO)</sub>               | SDI to SDO delay time                  | $C_L$ = 30 pF; Normal, ListenOnly,<br>Standby or Sleep mode; SPI<br>address bits and read-only bit;<br>pin SDO    |            | -   | -   | 50   | ns   |
| t <sub>WH(S)</sub>                    | chip select pulse width HIGH           | Normal, ListenOnly, Standby or Sleep mode   |            | 250 | -   | -    | ns   |
| t <sub>d(SCKL-SCSNL)</sub>            | delay time from SCK LOW to SCSN<br>LOW | Normal, ListenOnly, Standby or Sleep mode; pin SCSN   |            | 50  | -   | -    | ns   |
| t <sub>to(SPI)</sub> <sup>[7]</sup>   | SPI time-out time                      |   | [4]        | 1.6 | -   | 2.4  | ms   |
| CAN partial ne                        | etworking                              |   |            |     |     |      |      |
| N <sub>bit(idle)</sub> <sup>[6]</sup> | number of idle bits                    | before a SOF is accepted  | [3]        | 6   | -   | 10   | -    |
| t <sub>fltr(bit)</sub> dom            | dominant bit filter time               | arbitration bit rate ≤ 500 kbit/s;<br>IDFS = 0x0  | [3]<br>[8] | 5   | -   | 17.5 | %    |
|                                       |  | ISO bitfilter 1; IDFS = 0x1   | [8]        | 5   | -   | 17.5 | %    |
|                                       |  | ISO bitfilter 2; IDFS = 0x2   | [3]        | 2.5 | -   | 8.75 | %    |
|                                       |  | IDFS = 0x3  | [3]        | 18  | -   | 93   | ns   |
|                                       |  | IDFS = 0x4  | [3]        | 42  | -   | 119  | ns   |
|                                       |  | IDFS = 0x5  | [3]        | 67  | -   | 145  | ns   |
|                                       |  | IDFS = 0x6  | [3]        | 91  | -   | 170  | ns   |
| General purpo                         | ose I/Os; pins GPIOx (TJA1445B only)   | -   |            |     |     | 1    | '    |
| t <sub>fitr</sub>                     | filter time                            | pin configured as input except<br>for GPIOxFS = 0x03 (TXEN_N<br>input) and GPIO2FS = 0x05 or<br>0x07 (TXD2 input) | [9]        |     | -   | 21   | μs   |
|                                       |  | pin configured as TXEN_N input<br>GPIOxFS = 0x03  | [9]        | 1   | -   | 5    | μs   |
|                                       |  | · · ·   |            |     |     |      |      |

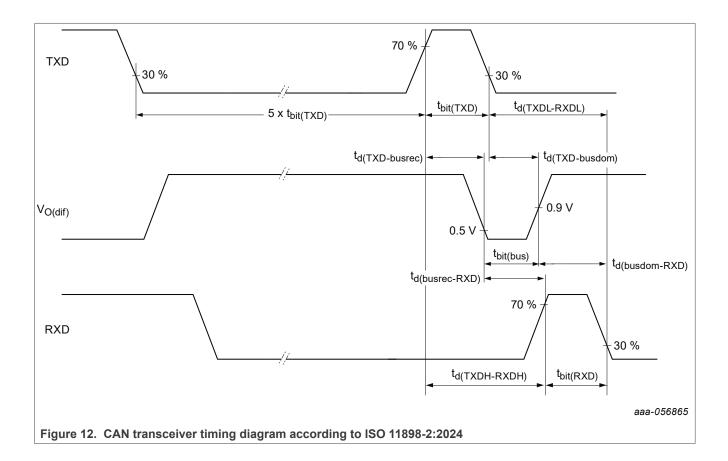
### Table 50. Dynamic characteristics...continued

# $T_{vj}$ = -40 °C to +150 °C; $V_{CC}$ = 4.5 V to 5.5 V; $V_{IO}$ = 1.71 V to 5.5 V; $V_{BAT}$ = 4.75 V to 40 V; $R_L$ = 60 $\Omega$ unless specified otherwise; all voltages are defined with respect to ground.<sup>[1]</sup>

| Symbol                    | Parameter   | Conditions   |             | Min  | Тур | Max  | Unit |
|---------------------------|---|--|-------------|------|-----|------|------|
| t <sub>w(min)</sub>       | minimum pulse width   | pin configured as output except<br>when RXD2 option is selected<br>for GPIO1     | [3]         | 3    | -   | -    | μs   |
| Transmitter e             | enable/disable input; pin TXEN_N (TJA14                           | 445B only)   |             |      | ·   |      |      |
| t <sub>fltr</sub>         | filter time   |  | [9]         | 1    | -   | 5    | μs   |
| Mode transit              | ions; see <u>Section 7.2, Figure 6</u> and <u>Figur</u>           | <u>re 7</u>  |             |      |     |      |      |
| t <sub>t(moch)</sub>      | mode change transition time                                       |  | [3]         | -    | -   | 50   | μs   |
| t <sub>startup</sub>      | start-up time   |  | [3]         | -    | -   | 1    | ms   |
| t <sub>startup(RXD)</sub> | RXD start-up time   | after local or remote wake-up detected   | [3]<br>[10] | 0    | -   | 20   | μs   |
| t <sub>startup(INH)</sub> | INH start-up time   | after local or remote wake-up<br>detected; transition from Sleep<br>to Standby   | [3]<br>[11] | 0    | -   | 40   | μs   |
| t <sub>t(snm)</sub>       | SNM transition time   | bus dominant time for Start-to-<br>Normal mode boot                              | [3]<br>[12] | 11   | -   | 16   | ms   |
| t <sub>to(MCU)</sub>      | MCU time-out time   | (1): LUVIOSEL = 0; t <sub>to(MCU)1</sub>   | [3]         | 825  | -   | 1300 | ms   |
|                           |   | (2): LUVIOSEL = 1; $t_{to(MCU)2}$  | [3]         | 1650 | -   | 2600 | ms   |
| Local wake-u              | up input; pin WAKE, see <u>Section 7.2.2</u> ar                   | nd <u>Table 36<sup>[3]</sup></u>   |             |      |     |      |      |
| t <sub>wake</sub>         | wake-up time  | in response to a falling or rising<br>edge on pin WAKE; Standby or<br>Sleep mode | [13]        |      |     |      |      |
|                           |   | short wake-up time:<br>WFC = 0   | [3]         | 20   | -   | 50   | μs   |
|                           |   | long wake-up time: WFC = 1   | [3]         | 12   | -   | 18   | ms   |
| Undervoltage              | e detection; see <u>Table 8</u> and <u>Table 12<sup>[3]</sup></u> |  |             | 1    |     | 1    | .1   |
| t <sub>det(uv)</sub>      | undervoltage detection time                                       | ≥ 100 mV input overdrive   |             |      |     |      |      |
|                           |   | on pin VBAT  |             | -    | -   | 30   | μs   |
|                           |   | on pin VCC   |             | -    | -   | 36   | μs   |
|                           |   | on pin VIO   |             | -    | -   | 36   | μs   |
| t <sub>det(uv)</sub> long | long undervoltage detection time                                  | on pin VIO; LUVIOSEL = 0;<br>t <sub>det(uv)long1</sub>                           | [14]        |      | -   | 160  | ms   |
|                           |   | on pin VIO; LUVIOSEL = 1;<br>t <sub>det(uv)long2</sub>                           | [14]        | 850  | -   | 1150 | ms   |
| t <sub>rec(uv)</sub>      | undervoltage recovery time  | ≥ 100 mV input overdrive   |             |      |     |      |      |
|                           |   | on pin VBAT  |             | -    | -   | 50   | μs   |
|                           |   | on pin VCC   |             | -    | -   | 56   | μs   |
|                           |   | on pin VIO   |             | -    | -   | 46   | μs   |

[1] All parameters are guaranteed over the junction temperature range by design. Factory testing uses correlated test conditions to cover the specified temperature and power supply voltage ranges.

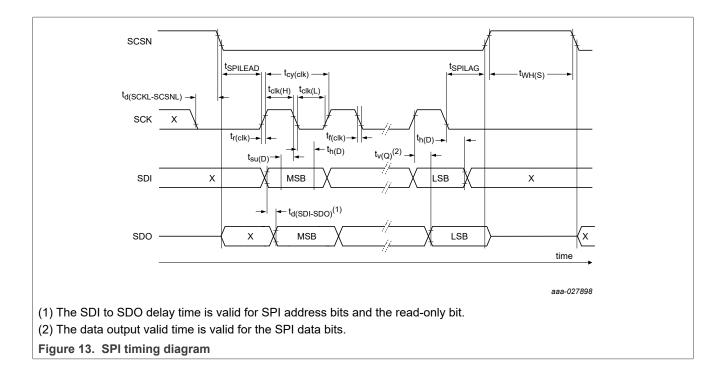
- [2] Compliance with parameter set B requirements implies compliance for parameter set A (t<sub>bit(TXD)</sub> ≥ 500 ns, up to 2 Mbit/s).
- [3] Not tested in production; guaranteed by design.
- [4] Time-out occurs between the min and max values. Time-out is guaranteed not to occur below the min value; time-out is guaranteed to occur above the max value.
- [5] A dominant/recessive phase shorter than the min value is guaranteed not be seen as a dominant/recessive bit; a dominant/recessive phase longer than the max value is guaranteed to be seen as a dominant/recessive bit.
- [6] As specified in ISO 11898-2:2024.
- [7] See <u>Section 7.10.1</u>.
- [8] Up to 2 Mbit/s data bit rate.
- [9] Pulses shorter than the min value are guaranteed to be filtered out; pulses longer than the max value are guaranteed to be processed.
- [10] When a wake-up is detected, RXD start-up time is between the min and max values. RXD cannot be relied on below the min value; RXD can be relied on above the max value; see Figure 6 and Figure 7.
- [11] INH switches HIGH between the min and max values after a wake-up had been detected. INH is guaranteed to be floating below the min value and guaranteed to be HIGH above the max value; see Figure 6 and Figure 7.
- [12] The transition occurs between the min and max times. The transition is guaranteed not to occur below the min value; the transition is guaranteed to occur above the max value.
- [13] Wake-up occurs between min and max values. Wake-up is guaranteed not to occur below the min value; wake-up is guaranteed to occur above the max value.
- [14] An undervoltage longer than the max value is guaranteed to force a transition to Sleep mode; an undervoltage shorter than the min value is guaranteed not to force a transition to Sleep mode.



### **NXP Semiconductors**

## TJA1445

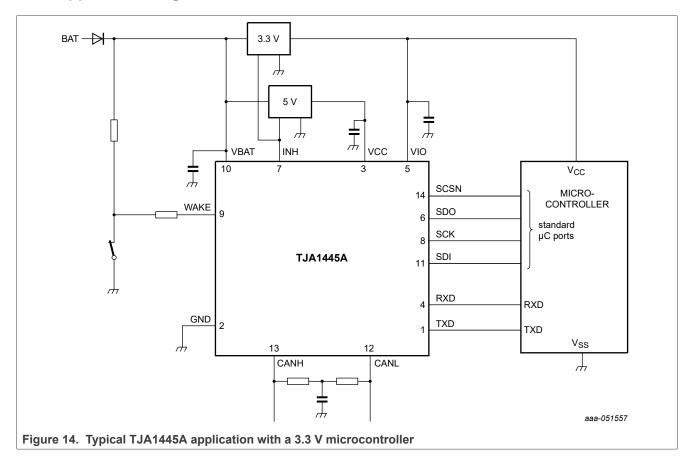
High-speed CAN transceiver with partial networking



### **12** Application information

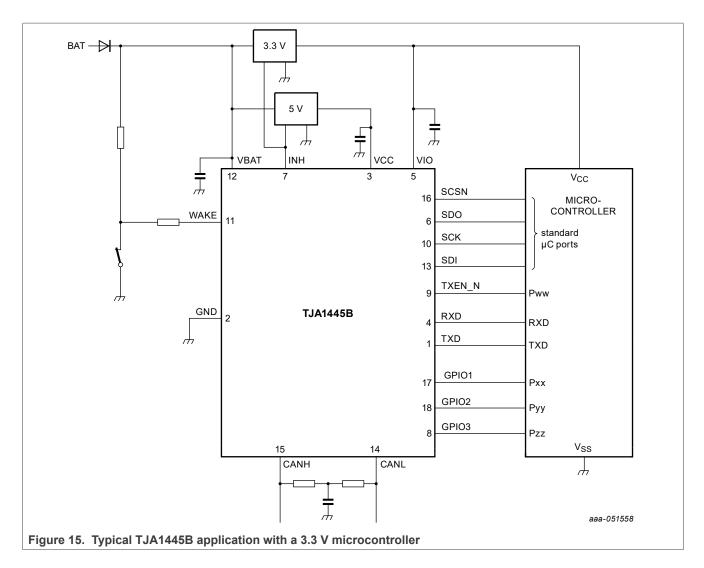
Example 12 V applications with components typically used with the TJA1445 are shown in <u>Figure 14</u> and <u>Figure 15</u>. See the application hints (<u>Section 12.2</u>) for further information about external components and PCB layout requirements.

### 12.1 Application diagram



## TJA1445

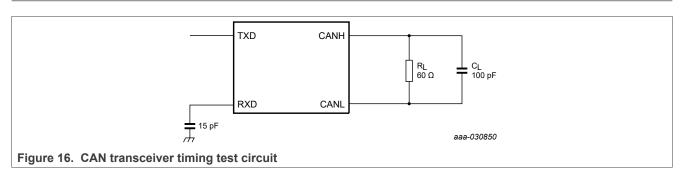
High-speed CAN transceiver with partial networking

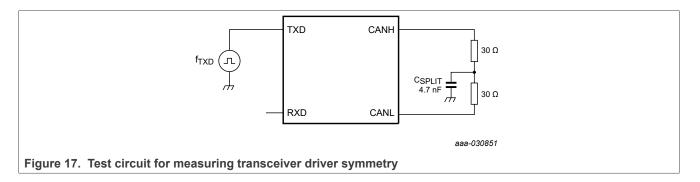


### 12.2 Application notes

Further information on the application of the TJA1445 can be found in NXP application notes AN14338 ' *TJA1445, TJA1465 application note*', available on request from NXP Semiconductors.

### 13 Test information

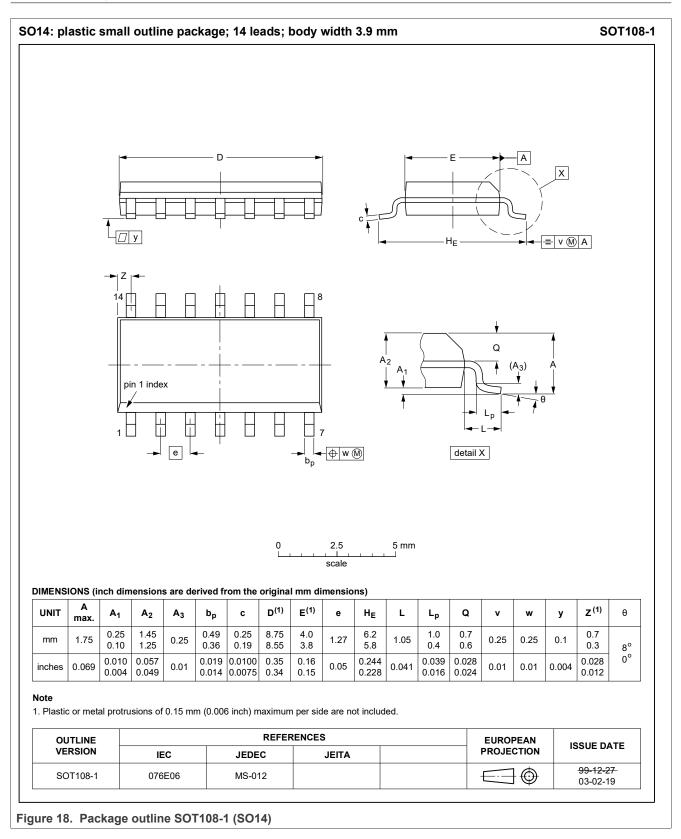


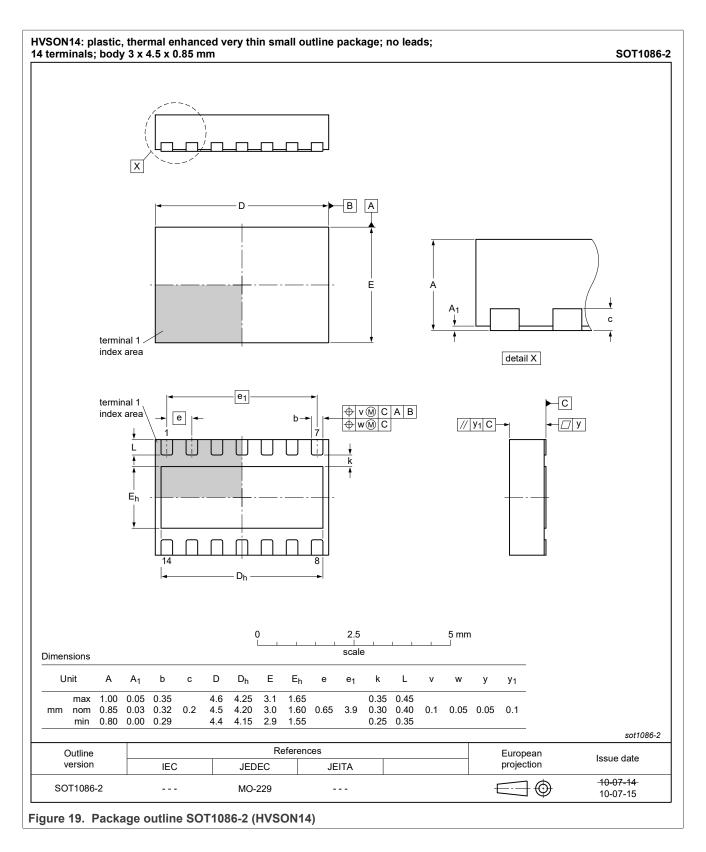


### 13.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q100 Rev-H - Failure mechanism based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

### 14 Package outline

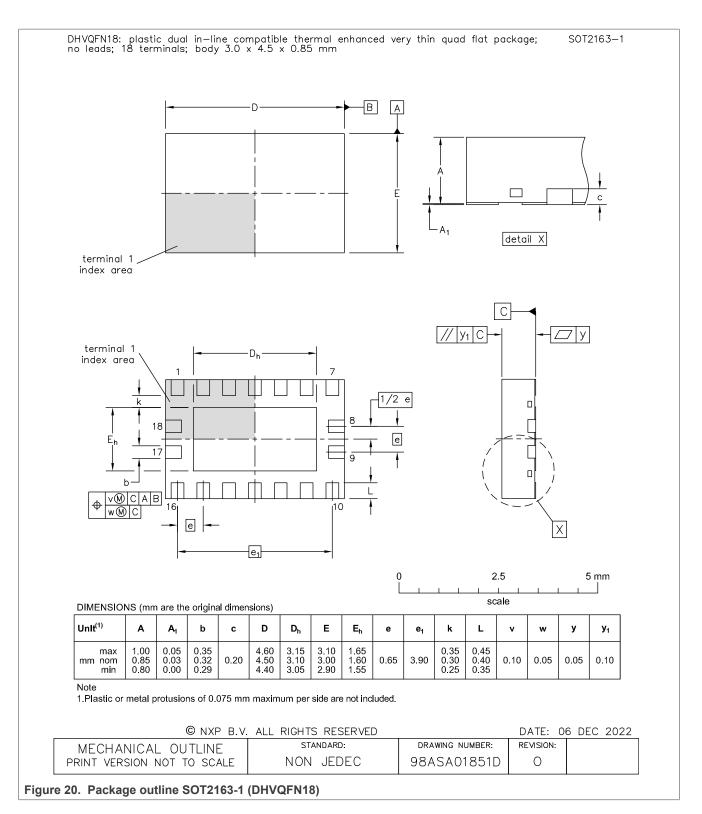




TJA1445 Product data sheet

## TJA1445

### High-speed CAN transceiver with partial networking



TJA1445 Product data sheet

### **15 Handling information**

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

### 16 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### **16.1** Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 16.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

### 16.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

### 16.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see Figure 21) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with <u>Table 51</u> and <u>Table 52</u>

| Package thickness (mm) | Package reflow temperature (°C) |       |  |  |  |
|------------------------|---------------------------------|-------|--|--|--|
|                        | Volume (mm <sup>3</sup> )       |       |  |  |  |
|                        | < 350                           | ≥ 350 |  |  |  |
| < 2.5                  | 235                             | 220   |  |  |  |
| ≥ 2.5                  | 220                             | 220   |  |  |  |

#### Table 51. SnPb eutectic process (from J-STD-020D)

#### Table 52. Lead-free process (from J-STD-020D)

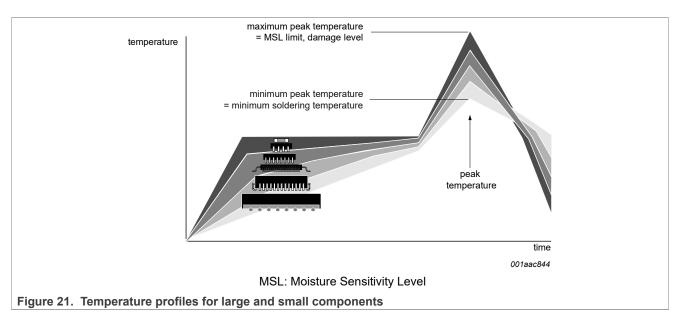
| Package thickness (mm) | Package reflow temperature (°C) |             |        |  |  |  |
|------------------------|---------------------------------|-------------|--------|--|--|--|
|                        | Volume (mm <sup>3</sup> )       |             |        |  |  |  |
|                        | < 350                           | 350 to 2000 | > 2000 |  |  |  |
| < 1.6                  | 260                             | 260         | 260    |  |  |  |
| 1.6 to 2.5             | 260                             | 250         | 245    |  |  |  |
| > 2.5                  | 250                             | 245         | 245    |  |  |  |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 21.

## TJA1445

### High-speed CAN transceiver with partial networking



For further information on temperature profiles, refer to Application Note AN10365 "Surface mount reflow soldering description".

## 17 Appendix: ISO 11898-2:2024 parameter cross-reference lists

| ISO 11898-2:2024  |  | NXP data she             | eet                                     |
|---|--|--------------------------|---|
| Parameter   | Notation   | Symbol                   | Parameter                               |
| HS-PMA maximum ratings of $V_{CAN_{-}H}$ , $V_{CAN_{-}L}$ ar    | d V <sub>Diff</sub>                                    | 1                        |   |
| Maximum rating  | V <sub>Diff</sub>                                      | V <sub>(CANH-CANL)</sub> | voltage between pin CANH and pin CANL   |
| General maximum rating  | V <sub>CAN_H</sub>                                     | V <sub>x</sub>           | voltage on pin x                        |
| Optional: Extended maximum rating                               | V <sub>CAN_L</sub>                                     |                          |   |
| HS-PMA recessive output characteristics, bus                    | biasing active   | /inactive                |   |
| Single ended output voltage on CAN_H                            | V <sub>CAN_H</sub>                                     | V <sub>O(rec)</sub>      | recessive output voltage                |
| Single ended output voltage on CAN_L                            | V <sub>CAN_L</sub>                                     |                          |   |
| Differential output voltage                                     | V <sub>Diff</sub>                                      | V <sub>O(dif)</sub>      | differential output voltage             |
| HS-PMA dominant output characteristics                          |  |                          | 1                                       |
| Single ended voltage on CAN_H                                   | V <sub>CAN_H</sub>                                     | V <sub>O(dom)</sub>      | dominant output voltage                 |
| Single ended voltage on CAN_L                                   | V <sub>CAN_L</sub>                                     |                          |   |
| Differential voltage on normal bus load                         | V <sub>Diff</sub>                                      | V <sub>O(dif)</sub>      | differential output voltage             |
| Differential voltage on effective resistance during arbitration |  |                          |   |
| Optional: Differential voltage on extended bus<br>load range    | -  |                          |   |
| Maximum HS-PMA driver output current                            | 1  | 1                        |   |
| Absolute current on CAN_H                                       | I <sub>CAN_H</sub>                                     | I <sub>O(sc)</sub>       | short-circuit output current            |
| Absolute current on CAN_L                                       | I <sub>CAN_L</sub>                                     |                          |   |
| HS-PMA static receiver input characteristics, b                 | us biasing act   | ive/inactive             |   |
| Recessive state differential input voltage range                | V <sub>Diff</sub>                                      | V <sub>th(RX)dif</sub>   | differential receiver threshold voltage |
| Dominant state differential input voltage range                 |  | V <sub>rec(RX)</sub>     | receiver recessive voltage              |
|   |  | V <sub>dom(RX)</sub>     | receiver dominant voltage               |
| HS-PMA receiver input resistance (matching)                     |  | 1                        |   |
| Differential internal resistance                                | R <sub>DIFF_pas_rec</sub>                              | R <sub>i(dif)</sub>      | differential input resistance           |
| Single-ended internal resistance                                | R <sub>SE_pas_rec_H</sub><br>R <sub>SE_pas_rec_L</sub> | R <sub>i</sub>           | input resistance                        |
| Matching of internal resistance                                 | m <sub>R</sub>   | ΔR <sub>i</sub>          | input resistance deviation              |
| HS-PMA maximum leakage currents on CAN_H                        | l and CAN_L, ເ   | inpowered                |   |
| Leakage current on CAN_H, CAN_L                                 | I <sub>CAN_H</sub><br>I <sub>CAN_L</sub>               | IL                       | leakage current                         |
| HS-PMA driver symmetry  | 1  | 1                        | 1                                       |
| Driver symmetry   | V <sub>sym_vcc</sub>                                   | V <sub>TXsym</sub>       | transmitter voltage symmetry            |
| Optional HS-PMA transmit dominant time-out                      |  |                          |   |
| Transmit dominant time-out                                      | <i>t</i> dom   | t <sub>to(dom)TXD</sub>  | TXD dominant time-out time              |

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### High-speed CAN transceiver with partial networking

| Table 53. ISO 11898-2:2024 to NXP data sheet p              | arameter conv               | version <sup>[1]</sup> con                             | tinued  |  |  |
|---|-----------------------------|--|---|--|--|
| ISO 11898-2:2024  |                             | NXP data sheet   |   |  |  |
| Parameter   | Notation                    | Symbol   | Parameter   |  |  |
| HS-PMA implementation loop delay requirement                | its for parame              | ter sets A, B a  | and C   |  |  |
| Loop delay for parameter sets A and B                       | t <sub>Loop</sub>           | t <sub>d(TXDH-RXDH)</sub>                              | delay time from TXD HIGH to RXD HIGH                    |  |  |
| Loop delay for parameter set C                              | -                           | t <sub>d(TXDL-RXDL)</sub>                              | delay time from TXD LOW to RXD LOW                      |  |  |
| Propagation delay from TXD to CAN_H/CAN_L                   | t <sub>prop(TXD_BUS)</sub>  | t <sub>d(TXD-busdom)</sub>                             | delay time from TXD to bus dominant                     |  |  |
| for parameter set C   |                             | t <sub>d(TXD-busrec)</sub>                             | delay time from TXD to bus recessive                    |  |  |
| Propagation delay from CAN_H/CAN_L to RXD                   | tprop(BUS_RXD)              | t <sub>d(busdom-RXD)</sub>                             | delay time from bus dominent to RXD                     |  |  |
| for parameter set C   |                             | t <sub>d(busrec-RXD)</sub>                             | delay time from bus recessive to RXD                    |  |  |
| HS-PMA implementation data signal timing requ               | uirements for               | parameter se   | ts A, B and C   |  |  |
| Transmitted recessive bit width variation                   | $t_{\Delta Bit(Bus)}$       | Δt <sub>bit(bus)</sub>                                 | transmitted recessive bit width deviation               |  |  |
| Received recessive bit width variation                      | $t_{\Delta Bit(RXD)}$       | $\Delta t_{bit(RXD)}$                                  | received recessive bit width deviation                  |  |  |
| Receiver timing symmetry                                    | $t_{\Delta REC}$            | Δt <sub>rec</sub>                                      | receiver timing symmetry                                |  |  |
| HS-PMA implementation SIC timing and impeda                 | ance for paran              | neter set C  |   |  |  |
| Differential internal resistance (CAN_H to CAN_L)           | R <sub>DIFF_act_rec</sub>   | R <sub>i(dif)actrec</sub>                              | active recessive phase differential input resistance    |  |  |
| Internal single-ended resistance                            | R <sub>SE_act_rec</sub>     | R <sub>i(actrec)</sub>                                 | active recessive phase input resistance                 |  |  |
| Start time of active signal improvement phase               | t <sub>act_rec_start</sub>  | t <sub>d(TXD-</sub><br>busactrec)start                 | delay time from TXD to bus active recessive start       |  |  |
| End time of active signal improvement phase                 | t <sub>act_rec_end</sub>    | t <sub>d(TXD-</sub><br>busactrec)end                   | delay time from TXD to bus active recessive end         |  |  |
| Start time of passive recessive phase                       | t <sub>pas_rec_start</sub>  | t <sub>d(TXD-</sub><br>buspasrec)start                 | delay time from TXD to bus passive recessive start      |  |  |
| PMA voltage wake-up control timing                          |                             |  | •   |  |  |
| CAN activity filter time, long/short                        | t <sub>Filter</sub>         | t <sub>wake(busdom)</sub><br>t <sub>wake(busrec)</sub> | bus dominant wake-up time<br>bus recessive wake-up time |  |  |
| Wake-up time-out  | t <sub>Wake</sub>           | t <sub>to(wake)bus</sub>                               | bus wake-up time-out time                               |  |  |
| Wake-up pattern signaling                                   | t <sub>Flag</sub>           | t <sub>startup(RXD)</sub>                              | RXD start-up time                                       |  |  |
|   | l lug                       | t <sub>startup(INH)</sub>                              | INH start-up time                                       |  |  |
|   |                             | t <sub>startup(ERR_N)</sub>                            | ERR_N start-up time                                     |  |  |
| Number of recessive bits before next SOF                    | I                           | ( <u>_</u> ,, <u>_</u> _,, <u>_</u> _,)                |   |  |  |
| Number of recessive bits before a new SOF shall be accepted | n <sub>Bits_idle</sub>      | N <sub>bit(idle)</sub>                                 | number of idle bits before a SOF is accepted            |  |  |
| BitFilter in CAN FD data phase                              | 1                           | 1  |   |  |  |
| CAN FD data phase bitfilter (option 1)                      | <b>P</b> Bitfilter_option1  | t <sub>fltr(bit)dom</sub>                              | dominant bit filter time                                |  |  |
| CAN FD data phase bitfilter (option 2)                      | PBitfilter_option2          |  |   |  |  |
| HS-PMA bus biasing control timing                           | ·                           | 1  | 1   |  |  |
| Time-out for bus inactivity                                 | <i>t</i> <sub>Silence</sub> | t <sub>to(silence)</sub>                               | bus silence time-out time                               |  |  |
| Bus bias reaction time                                      | t <sub>Bias</sub>           | t <sub>d(busact-bias)</sub>                            | bus bias reaction time                                  |  |  |

oroion<sup>[1]</sup> Table 52 ISO 11909 2:2024 to NVD data about actor cor

TJA1445 Product data sheet

[1] A number of proprietary NXP parameters are equivalent to parameters defined in ISO 11898-2:2024, but use different symbols. This conversion table allows ISO parameters to be cross-referenced with their NXP counterparts. The NXP parameters are defined in the Static and Dynamic characteristics tables. The conversion table provides a comprehensive listing - individual devices may not include all parameters.

## 18 Appendix: TJA1445x/TJA1446x/TJA1465x/TJA1466x family overview

#### Table 54. Feature overview of the the complete TJA1445x/TJA1446x/TJA1465x/TJA1466x family. Partial Networking V<sub>IO</sub> supply Data rate **Special features** ISO 26262 ASIL B compliance V<sub>IO</sub> undervoltage monitoring V<sub>IO</sub> overvoltage monitoring SIC ËD Up to 5 Mbit/s CAN to 8 Mbit/s CAN Selective wake-up **CAN FD** passive CAN XL passive Q&A watchdog SO/LIMP pin **FXEN\_N** pin RST\_N pin **GPIO** pins 1.8 V V<sub>IO</sub> 3.3 V V<sub>IO</sub> 5.0 V V<sub>IO</sub> d Device TJA1445A • • • • • • • • TJA1445B • 3 • • • • • • • • TJA1446A 2 • • • • • • • • • • TJA1446B 2 • • • • . • • • • • TJA1446C 2 • -• • • TJA1465A • • • • • • • • • . TJA1465B • • • • • • • • 3 • • • TJA1466A 2 • • . • • • • • • • . ٠ TJA1466B 2 • • • • • • • • • • • • TJA1466C 2 • • • • • • • • • • • •

### **19 Revision history**

### Table 55. Revision history

| Document ID   | Release date    | Description     |
|---------------|-----------------|-----------------|
| TJA1445 v.1.0 | 16 October 2024 | Initial version |

### Legal information

### Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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## **TJA1445**

### High-speed CAN transceiver with partial networking

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## TJA1445

High-speed CAN transceiver with partial networking

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